

Maintenance and Service Guide

HP Compaq Business Notebook nx7000 Compaq Presario Widescreen Notebook PC X1000

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Product Description

The HP Compaq Business Notebook nx7000 and Compaq Presario Widescreen Notebook PC X1000 offer advanced modularity, Intel Mobile Pentium-M processors with 64-bit architecture, industry-leading ATI Mobility Radeon Accelerated Graphics Port (AGP) implementation, and extensive multimedia support.



HP Compaq Business Notebook nx7000 and Compaq Presario Widescreen Notebook PC X1000

1.1 Models

Notebook models are shown in Tables 1-1 through 1-3.

Table 1-1HP Compaq nx7000 and Compaq Presario X1000 ModelNaming Conventions

Кеу										
С	Р	160	Y5	80	Υ	Ci	10	Р	XXXXXX-XXX	
1	2	3	4	5	6	7	8	9	10	
Key	Descri	ption		Opt	ions					
1	Brand/S designa				HP Co nx700	ompaq 00			Compaq Presario X1000	
2	Process	or type		P =	Intel F	Pentium	I-M			
3	Process	or spee	d		= 1.6 = 1.5				= 1.4 GHz = 1.3 GHz	
4	Display size/res			Y = 7 W =	(1920 wide \$ (1680 wide	JXGA × 1200 SXGA+ × 1050 XGA × 800)))	5 = 15.4 in		
5	Hard dri	ve size			80 G 60 G	_		40 = 40 GB		
6	Optical designa			D =	CD-R DVD- DVD-	ROM		W = DVD-ROM/ CD-RW combo		
7	Integrated communication/ wireless device C = combination LAN b = 802.11b i = 802.11b + Bluethu									
8	RAM			-	1024 512			25 = 256 MB		
9	Operatir	ng syste	m	H = Windows XP Home P = Windows XP F						
10	SKU#									

Table 1-2 HP Compaq nx7000 Models

All HP Compaq nx7000 models feature:

- TouchPad pointing device
- 8-cell, 4.4 wH lithium ion (Li ion) battery pack
- 1-year warranty on parts and labor

С	Р	160	Y5	80	W	Cb	51	Р	
Korea			DM9	42A A	B5				
C	Р	160	Y5	60	Y	Ci	51	Р	
France	•			06T AI		•••	•••		
	1	1					1	[
С	Р	160	Y5	60	w	Cb	51	Р	
Denmark European Internati France Germany Greece Hungary Israel Italy	zech Republic DG706A AKB eenmark DG706A ABY uropean DG706A ABB International rance DG706A ABF iermany DG706A ABF ierece DG706A AB7 ungary DG706A AKC pG706A ABT					Polan Portug Russia Saudi Slover Spain Swede Switze Turkey	NorwayDG706APolandDG706APortugalDG706ARussiaDG706ASaudi ArabiaDG706ASloveniaDG706ASpainDG706ASweden/FinlandDG706ASwitzerlandDG706ATurkeyDG706AUnited KingdomDG706A		
С	Р	160	W5	60	Y	Cb	51	Р	
Thailand		1	DM4	34A A	KL		1		
С	Р	160	W5	60	W	Cb	51	Р	
Asia Pacifi	с		DM9	45A U	UF	Thailand			DM945A AKL
С	Р	160	W5	60	W	Cb	51	Р	
Brazil French Canada Japan			DL855A AC4 DL855A ABC DM436A ABJ			Latin America United States			DL855A ABM DL855A ABA
С	Р	150	Y5	60	W	Cb	51	Ρ	
Korea	1	1	DM9	41A A	B5		1	1	

			-			i			
С	Р	150	Y5	40	W	Ci	51	Р	
Belgium			DG7	05A U	UG	Norwa	iy		DG705A ABN
Czech Rep	oublic		DG7	05A AI	KB	Polan	d		DG705A AKD
Denmark			DG7	05A AI	BY	Portug	gal		DG705A AB9
European			DG7	05A AI	BB	Russia	-		DG705A ACB
Internatio	onal					Saudi	Arabia	a	DG705A ABV
France			DG7	05A AI	BF	Slover	nia		DG705A AKN
Germany			DG7	05A AI	BD	Spain			DG705A ABE
Greece			DG7	05A AI	B7		en/Finl	and	DG705A AK8
Hungary			DG7	05A AI	KC	Switze	erland		DG705A UUZ
Israel			DG7	05A AI	BT	Turkey			DG705A AB8
Italy			DG7	05A AI	ΒZ		I Kingo	dom	DG705A ABU
The Nethe	rlands		DG7	05A AI	BH				
С	Р	150	Y5	40	W	Ci	51	Р	
France		1	DG7	05T AI	ЗF				
С	Р	150	Y5	40	С	Cb	51	Р	
Korea			DM940A AB5						
С	Р	150	W5	80	W	Cb	51	Н	
Asia Pacifi	С		DL848A UUF			Korea			DL848A AB1
Australia/N	lew Ze	aland	DL848A ABG			Thailand			DL848A AKL
Japan			DL84	ISA AE	3J				
С	Ρ	150	W5	80	W	Cb	51	Н	
Taiwan			DL85	50A AE	30				
С	Р	150	W5	80	W	Cb	51	Ρ	
Asia Pacifi	С		DL84	7A UL	JF	Korea			DL847A AB1
Australia/New Zealand			DL84	DL847A ABG			nd		DL847A AKL
Japan			DL84	7A AE	3J				
				1	1				·
С	Р	150	W5	80	W	Cb	51	Р	
Taiwan	wan DL849A AB0				30				
С	Ρ	150	W5	80	W	Cb	25	Р	
Asia Pacifi	C		DM943A UUF						

Table 1-2HP Compaq nx7000 Models (Continued)

HP Compaq nx7000 Models (Continued)											
С	Р	150	W5	40	W	Cb	51	Р			
Asia Pacific DN728A UUF							1	1			
С	Р	150	W5	40	W	Cb	25	Р			
Asia Pacific	0		DM9	44A U	UF				•		
С	Р	150	W5	40	D	Cb	25	Н			
Taiwan			DL84	2A AE	30				•		
С	Р	150	W5	40	D	Cb	25	Ρ			
People's Re of China	epubli	C	DL83	88A AE	32		<u> </u>	<u> </u>			
С	Р	140	Y5	40	W	Cb	51	Р			
Korea		1	DM9	39A A	B5		1	1			
С	Р	140	W5	60	W	Ci	51	Ρ			
Hong Kong	I		DL853A AB5								
С	Р	140	W5	60	W	Cb	25	Н			
Asia Pacific Australia/N Japan	-	aland	DL844A UUF DL844A ABG DL844A ABJ			Korea Thailand			DL844A AB1 DL844A AKL		
С	Р	140	W5	60	W	Cb	25	Н			
Hong Kong			DL84	DL846A AB5			n		DL846A AB0		
С	Ρ	140	W5	60	W	Cb	25	Н			
Hong Kong	I	1	DM4	37A A	B5		1				
С	Ρ	140	W5	60	W	Cb	25	Р			
Asia Pacific Australia/New Zealand Japan			DL843A UUF DL843A ABG DL843A ABJ			Korea Thailand		<u>.</u>	DL843A AB1 DL843A AKL		
С	Ρ	140	W5	60	W	Cb	25	Ρ			
Taiwan			DL84	I5A AE	30						

Table 1-2HP Compaq nx7000 Models (Continued)

С	Р	140	W5	40	W	Ci	25	Р	
Belgium			DG7	04A U	UG	Norwa	ay		DG704A ABN
Czech Rep	oublic		DG7	DG704A AKB			d		DG704A AKD
Denmark			DG7	04A AI	BY	Portug	gal		DG704A AB9
European			DG7	04A AI	BB	Russia	a		DG704A ACB
Internati	onal					Saudi	Arabia	a	DG704A ABV
France			DG7	04A AI	BF	Slover	nia		DG704A AKN
Germany			DG4	20A AI	BD	Spain			DG704A ABE
Greece			DG7	04A AI	B7	Swede	en/Finl	and	DG704A AK8
Hungary				04A Al		Switze	erland		DG704A UUZ
Israel				04A Al		Turkey			DG704A AB8
Italy			DG7	04A Al	ΒZ	United	d Kingo	dom	DG704A ABU
The Nethe	rlands		DG7	04A Al	BH				
С	Р	140	W5	40	W	Ci	25	Р	
France			DG704T ABF						
С	Р	140	W5	40	W	Cb	25	Н	
Japan	1	1]	DM4	DM435A ABJ			1	1	
С	Р	140	W5	40	W	Cb	25	Р	
Thailand			DM433A AKL						
С	Р	140	W5	40	D	Cb	51	Р	
Brazil			DL854A AC4			Latin America			DL854A ABM
French Ca	nada			54A AE		United	d State	S	DL854A ABA
С	Р	140	W5	40	D	Cb	25	Р	
People's R of China	5	DL83	37A AE	32		<u>.</u>			
С	Р	140	W5	40	D	Cb	25	Р	
Asia Pacific			DM438A UUF			People's Republic of China			DM438A AB2
						Thaila			DM438A AKL

Table 1-2HP Compaq nx7000 Models (Continued)

	paq r	1x700)0 M	odels	(Con	ntinue	ed)		
С	Р	140	W5	40	D	Cb	25	Р	
Korea	I		DM938A AB5				I	1	1
С	Р	140	W5	40	С	Cb	25	Р	
Korea	1	-	DM9	37A A	B5		1	Į	•
С	Р	130	W5	40	W	Ci	25	Р	
Hong Kong	9		DL85	52A AE	35				•
С	Р	130	W5	40	D	Ci	25	Р	
Asia Pacifi	с		DL85	DL851A UUF		Hong	Kong		DL851A AB5
С	Р	130	W5	40	D	Cb	25	Н	
Asia Pacifi Australia/N Hong Kong	lew Ze	aland	DL840A UUF DL840A ABG DL840A AB5		Japan Korea Thailand			DL840A ABJ DL840A AB1 DL840A AKL	
С	Р	130	W5	40	D	Cb	25	Р	
Asia Pacifi Australia/N Hong Kong Japan	lew Ze	aland	DL83 DL83	39A UU 39A AE 39A AE 39A AE	3G 35	Japan Korea Thaila		ish)	DL839A ACF DL839A AB1 DL839A AKL
С	Р	130	W5	40	D	Cb	25	Р	
Taiwan			DL84	1A AE	30				·
С	Р	130	W5	40	D	Cb	25	Р	
Korea			DM9	36A A	B5				
С	Р	130	W5	40	С	Cb	25	Р	
Korea			DM9	35A A	B5				·

Table 1-2HP Compaq nx7000 Models (Continued)

Table 1-3Compaq Presario X1000 Models

All Compaq Presario X1000 models feature:

- TouchPad pointing device
- 8-cell, 4.4 wH Li ion battery pack
- 1-year warranty on parts and labor

X1045	Р	160	Y5	80	W	Cb	51	Н	
Korea			DN6	06A AI	31				•
X1030	Р	160	Y5	60	Y	Cb	51	Н	
Australia/N	lew Ze	aland	DN5	91A AI	3G				
X1046	Р	160	Y5	60	W	Cb	51	Н	
Korea			DN6	07A AI	31				
X1029	Р	160	Y5	60	W	Cb	25	Н	
Australia/N	lew Ze	aland	DN6	DOA AI	3G				
X1015	Р	150	Y5	80	Y	Cb	10	Н	
United Sta	tes		DN624A ABA						
X1056	Р	150	Y5	60	Υ	Cb	25	Н	
People's R of China		C	DN6	17A AI	32				
X1049	Р	150	Y5	60	W	Cb	51	Н	
Hong Kong	9		DN6	10A AI	35				
X1023	Р	150	Y5	60	W	Cb	51	Н	
Asia Pacifi	с		DN58	34A U	UF				
X1055	Р	150	Y5	60	D	Cb	25	Н	
People's R of China		C	DN6	16A AI	32		<u> </u>	<u> </u>	
X1020	Р	150	W5	60	Υ	Cb	51	Н	
The Netherlands DM416A /			16A A	BH					

	Compaq Presario X1000						els (C	ontir	nued)
X1050	Р	150	W5	60	Y	Cb	51	Н	
Hong Kong	Hong Kong DN611A AB5								
X1044	Р	150	W5	60	W	Cb	51	Н	
Korea		-j	DN6	05A AI	B1				•
X1032	Р	150	W5	60	W	Cb	51	Н	
Asia Pacifi	с	-j	DN5	93A U	UF				•
X1058	Р	150	W5	60	W	Cb	25	Н	
Korea			DN6	19A AI	B1				
X1054	Р	150	W5	60	W	Cb	25	Н	
People's R of China		С	DN6	15A AI	B2		<u> </u>	<u> </u>	
X1010	Р	150	W5	40	W	Cb	51	Н	
Denmark Portugal	L	1	DL963A ABY DL963A AB9		Spain United Kingdom		dom	DL963A ABE DL963A ABU	
X1028	Р	150	W5	40	W	Cb	25	Н	
Asia Pacifi	с		DN5	39A U	UF				I
X1020	Р	140	Y5	80	Y	Cb	10	Р	
United Sta	tes		DK5	72A AE	BA		1	1	I
X1063	Р	140	Y5	60	W	Cb	25	Н	
People's R of China		С	DN6	23A AI	B2		1	1	
X1022	Р	140	Y5	60	W	Cb	25	Н	
Asia Pacifi	с		DN583A UUF			1	1		
X1048	Р	140	Y5	40	W	Cb	25	Н	
Hong Kong	Hong Kong DN609A AB5				1	I			
X1028	Р	140	W5	80	Y	Cb	51	Р	
United Sta	tes		DL89	98A AE	3A				<u>.</u>

	Compaq Presano X100						15 (C	Until	lueuj
X1037	Р	140	W5	60	W	Cb	51	Н	
Thailand	Thailand DN598A AKL								
X1036	Р	140	W5	60	W	Cb	51	Н	
Taiwan	·!		DN5	97A AI	B0		•		
X1018	Р	140	W5	60	W	Cb	51	Н	
United Sta	tes		DK5	74A AI	BA				•
X1010	Р	140	W5	60	W	Cb	51	Н	
Canada (E	nglish))	DL85	57A AE	3L	Frenc	h Cana	ada	DL857A ABC
X1007	Р	140	W5	60	W	Cb	51	Н	
Sweden/Fi	inland		DL964A AK8						
X1001	Р	140	W5	60	W	Cb	51	Н	
United Sta	tes		DK575A ABA						
X1057	Р	140	W5	60	W	Cb	25	Н	
Korea			DN6	18A AI	B1				
X1043	Р	140	W5	40	Y	Cb	51	Н	
Korea			DN6	04A AI	B1				
X1016	Р	140	W5	40	Y	Cb	51	Н	
France			DM4	15A A	BF	Italy			DM415A ABZ
X1062	Р	140	W5	40	W	Cb	51	Н	
Asia Pacifi	с		DN6	DN622A UUF					
X1012	Р	140	W5	40	W	Cb	51	Н	
France			DL96	65A AE	BF				·
X1052	Р	140	W5	40	W	Cb	25	Н	
People's R of China	lepublio	C	DN6	13A AI	B2				•

Korea	140 140 130	W5	40)3A AB 40 12A AB	W 31 D	Cb Cb	25	Η	
X1051 P People's Republic		W5	40	1	Cb	05		
People's Republic		-		D	Cb	05		
	130	DN6 ⁻	12A AE			25	Н	
	130			32				
X1021 P		Y5	40	D	Cb	25	Н	
Asia Pacific		DN58	32A UI	UF				
X1038 P	130	W5	60	W	Cb	51	Н	
Thailand		DN59	99A Ał	٢L				
X1010 P	130	W5	60	W	Cb	51	Н	
United States		DK57	71A AE	BA				I
X1035 P	130	W5	60	D	Cb	51	Н	
Taiwan		DN59	96a ae	30				I
X1006 P	130	W5	40	Υ	Cb	51	Н	
France		DM9	33A AI	BF				
X1060 P	130	W5	40	W	Cb	51	Н	
Thailand		DN62	20A Ał	٢L				I
X1012 P	130	W5	40	W	Cb	51	Н	
United States		DN58	35A AB	BA				I
X1061 P	130	W5	40	W	Cb	25	Н	
Asia Pacific	Asia Pacific DN621A UUF						1	
X1047 P	130	W5	40	W	Cb	25	Н	
Hong Kong		DN60)8a Ab	35				I
X1041 P	130	W5	40	W	Cb	25	Н	
Korea		DN60)2A AB	31				

							(-		,
X1031	Р	130	W5	40	W	Cb	25	н	
Asia Pacifi	Asia Pacific DN592A UUF								
X1005	Р	130	W5	40	W	Cb	25	Н	
Belgium Denmark France		<u>.</u>	DL681A UUG DL681A ABY DL681A ABF			The Netherlands Portugal Spain			DL681A ABH DL681A AB9 DL681A ABE
Italy			DL68	B1A AE	3Z	Swed	en/Finl	and	DL681A AK8
Latin Ame	rica		DL85	58A AE	3M	United	d Kingo	dom	DL681A ABU
X1034	Р	130	W5	40	D	Cb	25	Н	
Taiwan			DN595A AB0						
X1033	Р	130	W5	40	D	Cb	25	Н	
Asia Pacifi	с	r	DN5	94A U	UF	Thailand			DN594A AKL
X1027	Р	130	W5	40	D	Cb	25	Н	
Asia Pacifi Australia/N	-	aland		38A U 88A AI		Thailand		1	DN588A AKL
X1040	Р	130	W5	40	С	Cb	25	Н	
Korea		r	DN601A AB1			1			
X1026	Р	130	W5 40 C		Cb	25	Н		
	Asia Pacific DN587A UUF Australia/New Zealand DN587A ABG			Thaila	ind	1	DN587A AKL		

1.2 Features

- Intel Mobile Pentium-M 1.6-, 1.5-, 1.4-, or 1.3-GHz processors with 400-MHz processor side bus and 512-KB L2 cache, varying by notebook model
- 15.4-inch wide UXGA (1920 × 1200), wide SXGA+ (1680 × 1050), or wide XGA (1280 × 800) TFT display with over 16.7 million colors, varying by notebook model

- ATI Mobility Radeon graphics with 32- or 64-MB DDR SDRAM
- 80-, 60-, or 40-GB high-capacity hard drive, varying by notebook model
- 256-MB high-performance Synchronous DRAM (SDRAM), expandable to 2.0 GB
- Microsoft Windows XP Home or XP Pro, varying by notebook model
- Full-size Windows 98 keyboard
- TouchPad pointing device with on/off button and dedicated scroll up/down surface
- 56-Kbps V.92 modem integrated on the system board
- Integrated Secure Digital (SD) flash media slot
- Integrated 10/100 network interface card (NIC)
- Integrated wireless support for mini PCI 802.11a/b/g and Bluethumb local area network (LAN) devices
- Support for one Type II PC Card slot with support for both 32-bit CardBus and 16-bit PC Cards
- External 65 watt AC adapter with power cord
- 8-cell Li ion battery pack
- JBL Pro speakers
- Support for the following optical drives:
 - □ 24X Max DVD/CD-RW combination drive
 - □ 8X Max DVD-RW drive
 - □ 24X Max CD-ROM drive

- Connectors for:
 - □ Microphone
 - □ Stereo speaker/headphone
 - □ Infrared
 - □ DC power
 - External monitor
 - □ S-Video
 - **USB** (3)
 - □ RJ-45 (network interface card, [NIC])
 - □ RJ-11 (modem)
 - Parallel
 - □ 1394 digital
 - □ One Type II PC Card slot
 - Docking

1.3 Clearing a Password

If the notebook you are servicing has an unknown password, follow these steps to clear the password. These steps also clear CMOS:

- 1. Prepare the notebook for disassembly (refer to Section 5.3, "Preparing the Notebook for Disassembly," for more information).
- 2. Remove the real time clock (RTC) battery (refer to Section 5.7, "RTC Battery").
- 3. Wait approximately five minutes.
- 4. Replace the RTC battery and reassemble the notebook.
- 5. Connect AC power to the notebook. Do **not** reinsert the battery pack at this time.
- 6. Turn on the notebook.

All passwords and all CMOS settings have been cleared.

1.4 Power Management

The notebook comes with power management features that extend battery operating time and conserve power. The notebook supports the following power management features:

- Standby
- Hibernation
- Setting customization by the user
- Hotkeys for setting level of performance
- Battery calibration
- Lid switch Standby/resume
- Power/Standby button
- Advanced Configuration and Power Management (ACP) compliance

1.5 External Components

The external components on the front and left side of the notebook are shown in the following illustration and described in Table 1-4.



Front and Left Side Components

Item	Component	Function
1	PC Card slot	Supports an optional Type I or Type II 32-bit (CardBus) or 16-bit PC Card.
2	PC Card eject button	Ejects an optional PC Card from the PC Card slot.
3	Optical drive	Supports an optical disc.
4	SD (Secure Digital) Card slot	Supports SD cards and multimedia cards.
5	Microphone jack	Connects an optional monaural or stereo microphone.
6	Audio line-out jack	Connects optional headphone or powered stereo speakers. Also connects the audio function of an audio/video device such as a television or VCR.
7	Display release latch	Opens the notebook.
8	Wireless device button	Turns an optional internal wireless device on or off.

Table 1-4 Front and Left Side Components

The notebook rear panel and right side components are shown in the following illustration and described in Table 1-5.



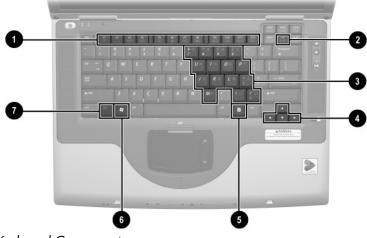
Rear Panel and Right Side Components

Table 1-5	
Rear Panel and Right Side Components	5

Item	Component	Function
1	Infrared port	Provides wireless communication between the notebook and an optional IrDA-compliant device.
2	Power connector	Connects an AC adapter cable.

R	ear Panel and Right	Table 1-5 t Side Components <i>(Continued)</i>
ltem	Component	Function
3	Security cable slot	Attaches an optional security cable to the notebook.
4	Vents (2)	Allow airflow to cool internal components.
\triangle	surfaces which cannot o	overheating, use the notebook only on hard obstruct the vents. Do not allow a soft ng, clothing, or a thick rug, to block airflow.
5	External monitor connector	Connects an optional VGA external monitor or projector.
6	S-Video jack	Connects an optional S-Video device, such as a television, VCR, camcorder, projector, or video capture card.
7	USB connectors (3)	Connect optional 2.0-compliant USB devices.
8	RJ-45 network jack	Connects an Ethernet network cable.
9	RJ-11 telephone jack	Connects a modem cable.
10	Parallel connector	Connects an optional parallel device such as a printer.
11	1394 connector	Connects an optional 1394 device such as a camcorder or digital camera.

The notebook keyboard components are shown in the following illustration and described in Table 1-6.

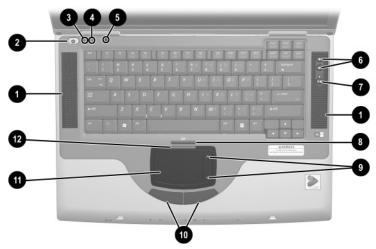


Keyboard Components

Item	Component	Function
1	F1 through F12 function keys	Perform system and application tasks. When combined with the Fn key, the function keys F1 and F3 through F12 perform additional tasks as hotkeys.
2	num lk key	Enables numeric lock and the internal keypad.
3	Internal keypad	Can be used like the keys on an external numeric keypad.
4	Cursor control keys	Move the cursor around the screen.
5	Applications key	Displays a shortcut menu for items beneath the pointer.
6	Microsoft logo key	Display the Windows Start menu.
7	Fn key	Executes frequently used system functions when pressed in combination with another key.

Table 1-6Keyboard Components

The notebook top components are shown in the following illustration and described in Table 1-7.



Top Components

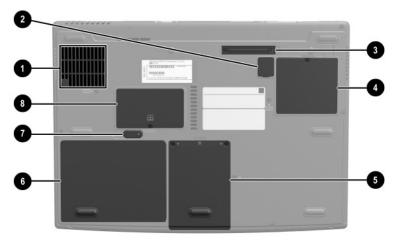
Table 1-7 Top Components

ltem	Component	Function
1	Stereo speakers (2)	Produce stereo sound.
2	Power button	When the notebook is:
		 Off, press to turn on the notebook. On, briefly press to initiate Hibernation.
		 In Standby, briefly press to resume from Standby.
		In Hibernation, briefly press to restore from Hibernation.

Top Components (Continued)				
Item	Component	Function		
3	Caps lock light	On: Caps lock is on.		
4	Num lock light	On: Num lock or the internal keypad is on.		
5	Display lid switch	If the notebook is closed while on, turns off the display.		
		If the notebook is opened while in Standby, turns on the notebook (resumes from Standby).		
6	Volume buttons (2)	Increase or decrease system volume.		
7	Mute button	Mutes or restores volume.		
8	TouchPad on/off button	Enables/disables the TouchPad.		
9	TouchPad scroll zones (2)	Scroll upward or downward.		
10	Left and right TouchPad buttons	Function like the left and right buttons on an external mouse.		
11	TouchPad	Moves the pointer and selects or activates items on the screen.		
12	TouchPad light	On: TouchPad is enabled.		

Table 1-7Top Components (Continued)

The external components on the bottom of the notebook are shown in the following illustration and described in Table 1-8.



Bottom Components

Table 1-8 Bottom Components

Bettern Gempenente				
ltem	Component	Function		
1	Fan vent	Allow airflow to cool internal components.		
\triangle	CAUTION: To prevent overheating, do not obstruct vents. Using the notebook on a soft surface, such as a pillow, blanket, rug, or thick clothing may block airflow.			
2	RTC battery compartment	Contains the RTC battery.		

ltem	Component	Function
3	Docking connector	Connects the notebook to an optional port replicator.
4	Mini PCI compartment	Contains the mini PCI wireless card.
5	Hard drive bay	Holds the internal hard drive.
6	Battery bay	Holds the battery pack.
7	Battery pack release latch	Releases a battery pack from the battery bay.
8	Memory expansion compartment	Contains one memory slot for an optional 128-, 256-, 512-, or 1024-MB memory module.

Table 1-8Bottom Components (Continued)

1.6 Design Overview

This section presents a design overview of key parts and features of the notebook. Refer to Chapter 3, "Illustrated Parts Catalog," to identify replacement parts, and Chapter 5, "Removal and Replacement Procedures," for disassembly steps. The system board provides the following device connections:

Memory expansion board

- Hard drive
- Display
- Keyboard and TouchPad
- Audio
- Intel Mobile Pentium-M processors
- Fan
- PC Card
- Modem, NIC, and wireless devices

The notebook uses an electrical fan for ventilation. The fan is controlled by a temperature sensor and is designed to turn on automatically when high temperature conditions exist. These conditions are affected by high external temperatures, system power consumption, power management/battery conservation configurations, battery fast charging, and software applications. Exhaust air is displaced through the ventilation grill located on the left side of the notebook.

CAUTION: To properly ventilate the notebook, allow at least a 7.6-cm (3-inch) clearance on the left and right sides of the notebook.

2

Troubleshooting



WARNING: Only authorized technicians trained by HP should repair this equipment. All troubleshooting and repair procedures are detailed to allow only subassembly/module level repair. Because of the complexity of the individual boards and subassemblies, do not attempt to make repairs at the component level or modifications to any printed wiring board. Improper repairs can create a safety hazard. Any indication of component replacement or printed wiring board modification may void any warranty or exchange allowances.

2.1 Computer Setup and Diagnostics Utilities

The notebook features two system management utilities:

Computer Setup—A system information and customization utility that can be used even when your operating system is not working or will not load. This utility includes settings that are not available in Windows.

- Diagnostics for Windows—A system information and diagnostic utility that is used within your Windows operating system. Use this utility whenever possible to:
 - Display system information.
 - □ Test system components.
 - Troubleshoot a device configuration problem in Windows 2000, Windows XP Professional, or Windows XP Home.

It is not necessary to configure a device connected to a USB connector on the notebook or an optional docking base.

Using Computer Setup

Information and settings in Computer Setup are accessed from the File, Security, or Advanced menus:

- 1. Turn on or restart the notebook. Press **F10** while the F10 = ROM-Based Setup message is displayed in the lower left corner of the screen.
 - \Box To change the language, press F2.
 - □ To view navigation information, press **F1**.
 - □ To return to the Computer Setup menu, press esc.
- 2. Select the File, Security, or Advanced menu.
- 3. To close Computer Setup and restart the notebook:
 - □ Select File > Save Changes and Exit and press enter. or
 - □ Select File > Ignore Changes and Exit and press enter.
- 4. When you are prompted to confirm your action, press F10.

Selecting from the File Menu

Table 2-1 File Menu		
Select	To Do This	
System Information	View identification information about the notebook, a docking base, and any battery packs in the system.	
	View specification information about the processor, memory and cache size, and system ROM.	
Save to Floppy	Save system configuration settings to a diskette.	
Restore from Floppy	Restore system configuration settings from a diskette.	
Restore Defaults	Replace configuration settings in Computer Setup with factory default settings. Identification information is retained.	
Ignore Changes and Exit	Cancel changes entered during the current session, then exit and restart the notebook.	
Save Changes and Exit	Save changes entered during the current session, then exit and restart the notebook.	

Selecting from the Security Menu

	Table 2-2 Security Menu	
Select	To Do This	
Setup Password	Enter, change, or delete a setup password. The setup password is called an administrator password in Computer Security, a program accessed from the Windows Control Panel.	
Power-on Password	Enter, change, or delete a power-on password.	
DriveLock Passwords	Enable/disable DriveLock; change a DriveLock User or Master password.	
	DriveLock Settings are accessible only when you enter Computer Setup by turning on (not restarting) the notebook.	
Password Options	Enable/disable:	
(Password options can be selected only when a	QuickLock	
power-on password has	QuickLock on Standby	
been set.)	QuickBlank	
	To enable QuickLock on Standby or QuickBlank, you must first enable QuickLock.	
Device Security	Enable/disable:	
	Ports or diskette drives*	
	■ Diskette write*	
	CD-ROM or diskette startup	
	Settings for a DVD-ROM can be entered in the CD-ROM field.	
System IDs	Enter identification numbers for the notebook, a docking base, and all battery packs in the system.	
*Not applicable to SuperDis	k LS-120 drives.	

Selecting from the Advanced Menu

Table 2-3 Advanced Menu		
Select	To Do This	
Language	Change the Computer Setup language.	
Boot Options	Enable/disable:	
	 QuickBoot, which starts the notebook more quickly by eliminating some startup tests. (If you suspect a memory failure and want to test memory automatically during startup, disable QuickBoot.) 	
	MultiBoot, which sets a startup sequence that can include most bootable devices and media in the system.	
Device Options	Enable/disable the embedded numeric keypad at startup.	
	Enable/disable multiple standard pointing devices at startup. (To set the notebook to support only a single, usually nonstandard, pointing device at startup, select Disable.)	
	Enable/disable USB legacy support for a USB keyboard. (When USB legacy support is enabled, the keyboard works even when a Windows operating system is not loaded.)	
	Set an optional external monitor or overhead projector connected to a video card in a docking base as the primary device. (When the notebook display is set as secondary, the notebook must be shut down before undocking from a docking base.)	

Advanced Menu (Continued)		
Select	To Do This	
Device Options (continued)	Change the parallel port mode from Enhanced Parallel Port (EPP, the default setting) to standard, bidirectional, EPP, or Enhanced Capabilities Port (ECP).	
	Set video-out mode to NTSC (default), PAL, NTSC-J, or PAL-M.*	
	Enable/disable all settings in the SpeedStep window. (When Disable is selected, the notebook runs in Battery Optimized mode.)	
	Specify how the notebook recognizes multiple identical docking bases that are identically equipped. Select Disable to recognize the docking bases as a single docking base; select Enable to recognize the docking bases individually, by serial number.	
	Enable/disable the reporting of the processor serial number by the processor to the software.	
HDD Self Test Options	Run a quick comprehensive self test on hard drives in the system that support the test features.	
America; PAL, in Europe,	vithin regions. However, NTSC is common in North Africa, and the Middle East; NTSC-J, in Japan; and outh and Central American regions may use NTSC,	

Table 2-3Advanced Menu (Continued)

2.2 Using Diagnostics for Windows

When you access Diagnostics for Windows, a scan of all system components is displayed on the screen before the diagnostics window opens.

You can display more or less information from anywhere within Diagnostics for Windows by selecting Level on the menu bar.

Diagnostics for Windows is designed to test HP components. If non-HP components are tested, the results might be inconclusive.

Obtaining, Saving, or Printing Configuration Information

- 1. Access Diagnostics for Windows by selecting Start > Settings > Control Panel > Diagnostics for Windows.
- 2. Select Categories, then select a category from the drop-down list.
 - \Box To save the information, select File > Save As.
 - □ To print the information, select File > Print.
- 3. To close Diagnostics for Windows, select File > Exit.

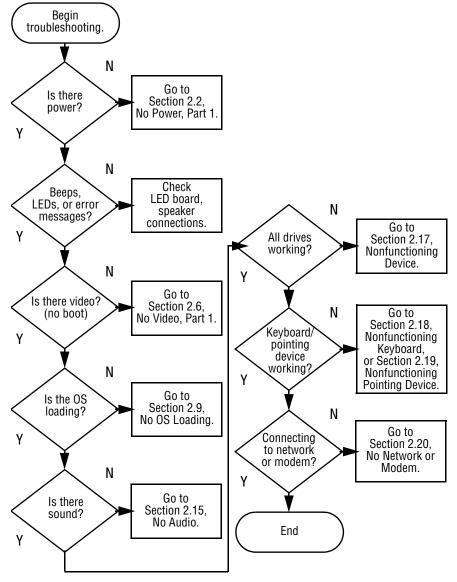
Obtaining, Saving, or Printing Diagnostic Test Information

- 1. Access Diagnostics for Windows by selecting Start > Settings > Control Panel > Diagnostics for Windows.
- 2. Select the Test tab.
- 3. In the scroll box, select the category or device you want to test.
- 4. Select a test type:
 - □ **Quick Test**—Runs a quick, general test on each device in a selected category.
 - □ Complete Test—Performs maximum testing on each device in a selected category.
 - □ **Custom Test**—Performs maximum testing on a selected device.
 - To run all tests for your selected device, select the Check All button.
 - To run only the tests you select, select the Uncheck All button, then select the checkbox for each test you want to run.
- 5. Select a test mode:
 - □ Interactive Mode—Provides maximum control over the testing process. You determine whether the test was passed or failed and might be prompted to insert or remove devices.
 - □ **Unattended Mode**—Does not display prompts. If errors are found, they are displayed when testing is complete.

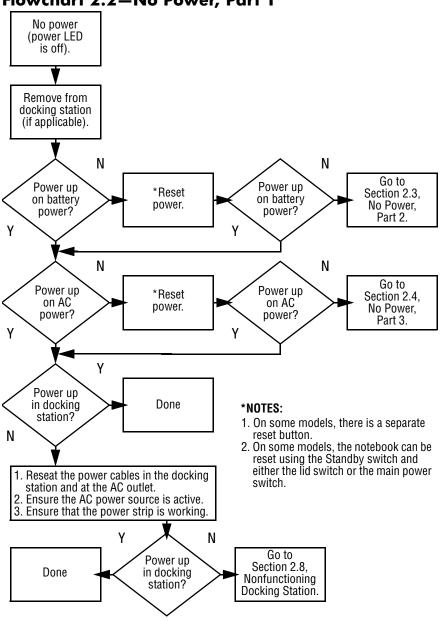
- 6. Select the Begin Testing button.
- 7. Select a tab to view a test report:
 - □ Status tab—Summarizes the tests run, passed, and failed during the current testing session.
 - □ Log tab—Lists tests run on the system, the number of times each test has run, the number of errors found on each test, and the total run time of each test.
 - □ **Error tab**—Lists all errors found in the notebook with the corresponding error codes.
- 8. Select a tab to save the report:
 - □ Log tab—Select the Log tab Save button.
 - **Error tab**—Select the Error tab Save button.
- 9. Select a tab to print the report:
 - □ Log tab—Select File > Save As, then print the file from your folder.

2.3 Troubleshooting Flowcharts

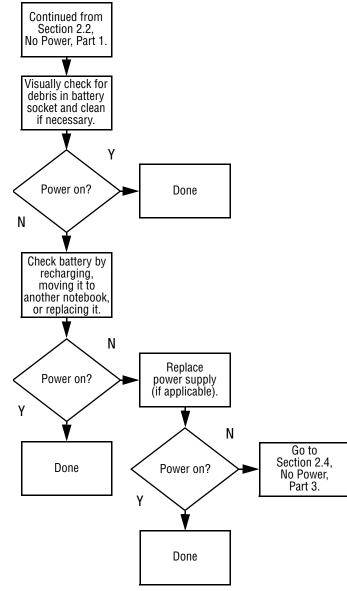
Table 2-4 Troubleshooting Flowcharts		
Flowchart	Description	
2.1	Initial troubleshooting	
2.2	No power, part 1	
2.3	No power, part 2	
2.4	No power, part 3	
2.5	No power, part 4	
2.6	No video, part 1	
2.7	No video, part 2	
2.8	Nonfunctioning docking station	
2.9	No operating system (OS) loading	
2.10	No OS loading from hard drive, part 1	
2.11	No OS loading from hard drive, part 2	
2.12	No OS loading from hard drive, part 3	
2.13	No OS loading from diskette drive	
2.14	No OS loading from CD- or DVD-ROM drive	
2.15	No audio, part 1	
2.16	No audio, part 2	
2.17	Nonfunctioning device	
2.18	Nonfunctioning keyboard	
2.19	Nonfunctioning pointing device	
2.20	No network or modem connection	



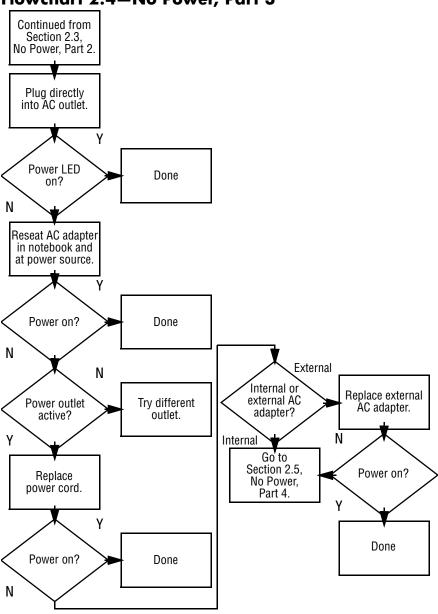
Flowchart 2.1—Initial Troubleshooting



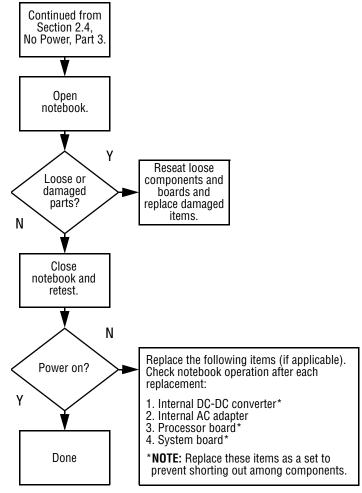
Flowchart 2.2–No Power, Part 1



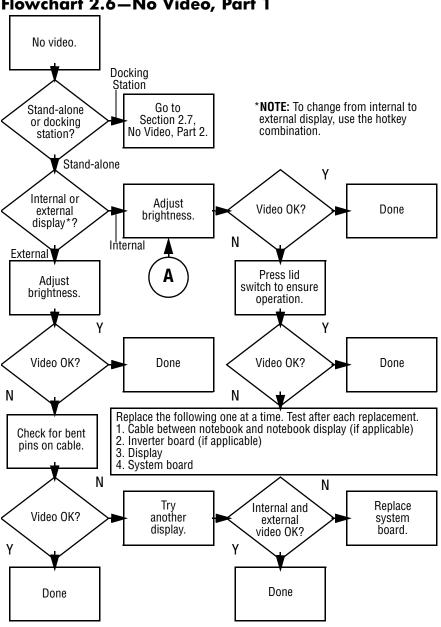
Flowchart 2.3–No Power, Part 2



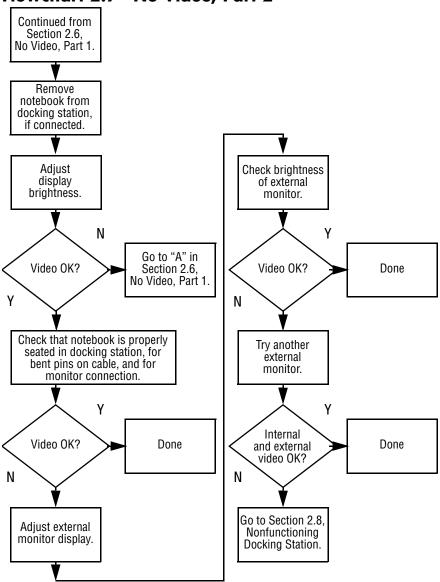
Flowchart 2.4–No Power, Part 3



Flowchart 2.5-No Power, Part 4

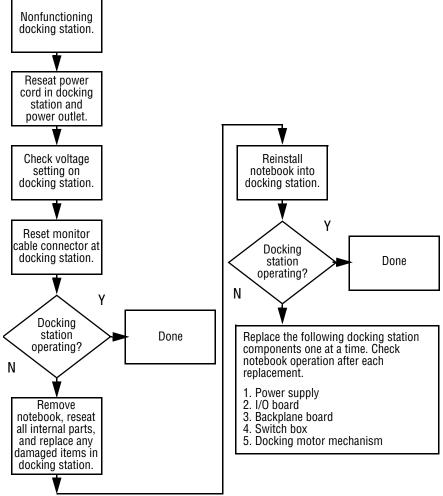


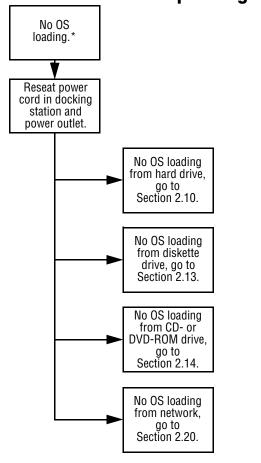
Flowchart 2.6—No Video, Part 1



Flowchart 2.7–No Video, Part 2

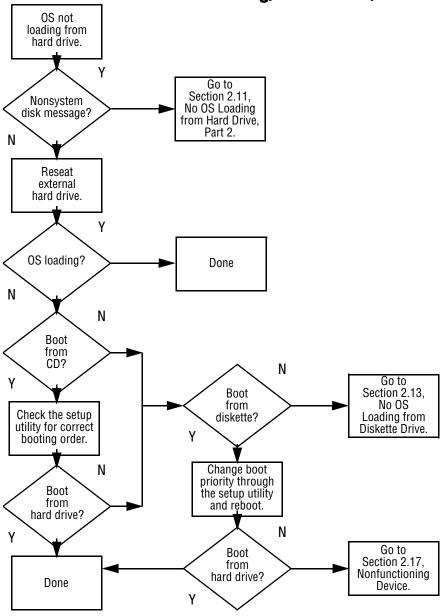
Flowchart 2.8—Nonfunctioning Docking Station (if applicable)



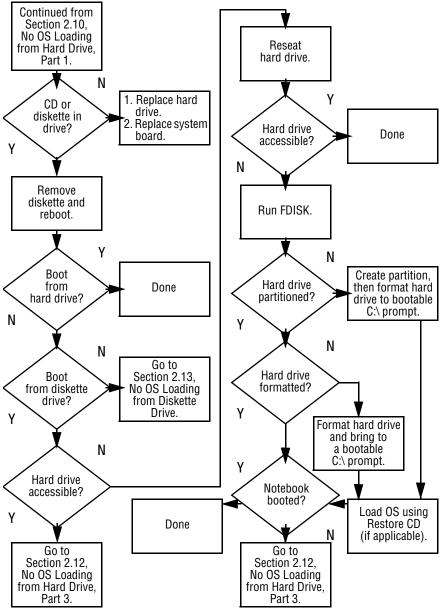


Flowchart 2.9—No Operating System (OS) Loading

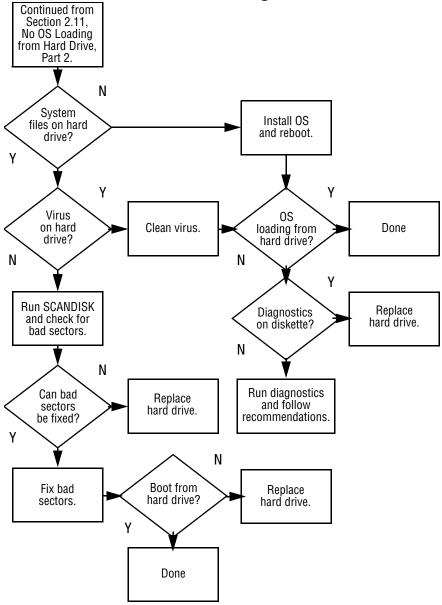
*NOTE: Before beginning troubleshooting, always check cable connections, cable ends, and drives for bent or damaged pins.



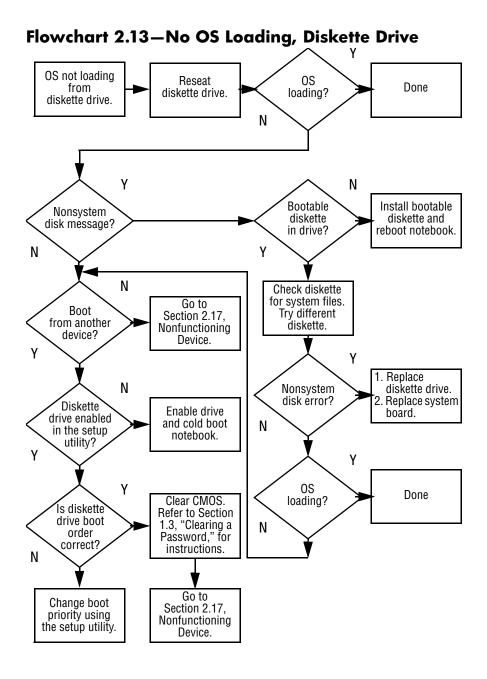
Flowchart 2.10–No OS Loading, Hard Drive, Part 1



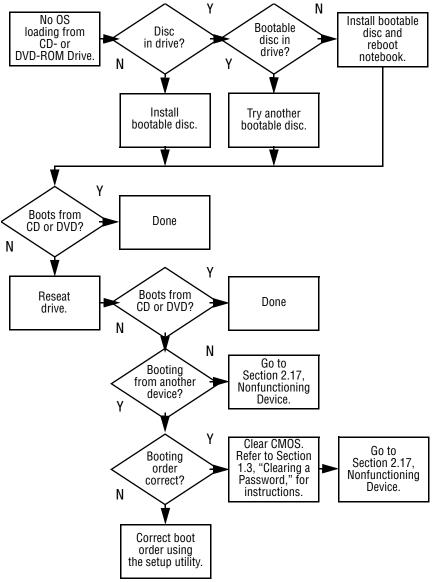
Flowchart 2.11—No OS Loading, Hard Drive, Part 2

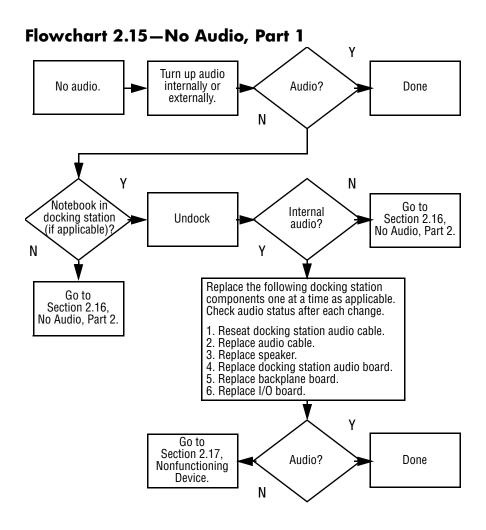


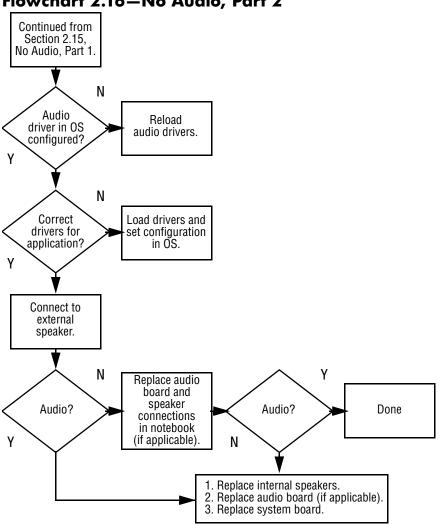
Flowchart 2.12-No OS Loading, Hard Drive, Part 3



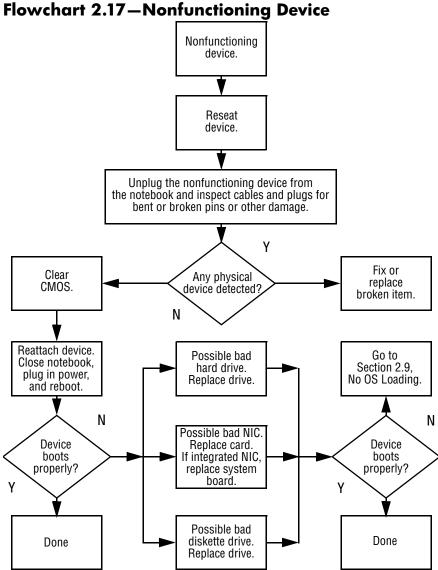


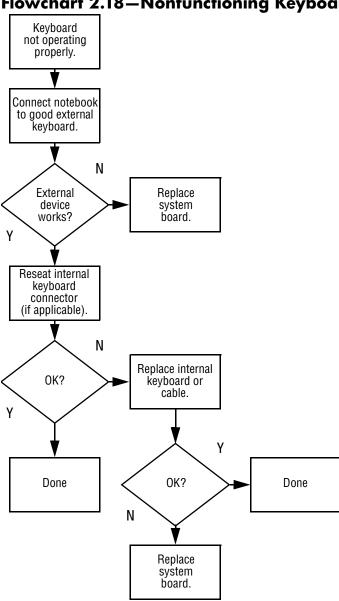




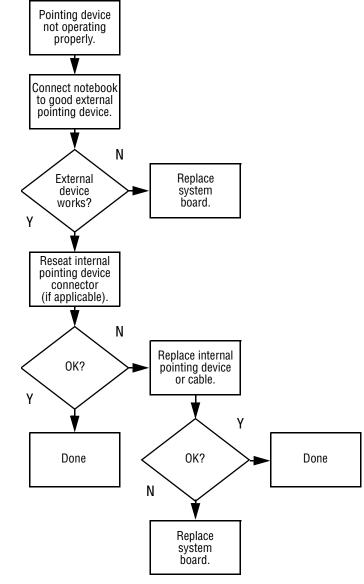


Flowchart 2.16–No Audio, Part 2



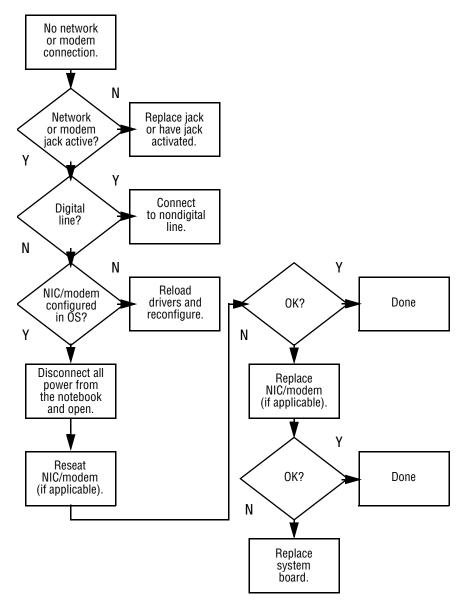


Flowchart 2.18-Nonfunctioning Keyboard



Flowchart 2.19—Nonfunctioning Pointing Device

Flowchart 2.20–No Network/Modem Connection



3

Illustrated Parts Catalog

This chapter provides an illustrated parts breakdown and a reference for spare part numbers and option part numbers.

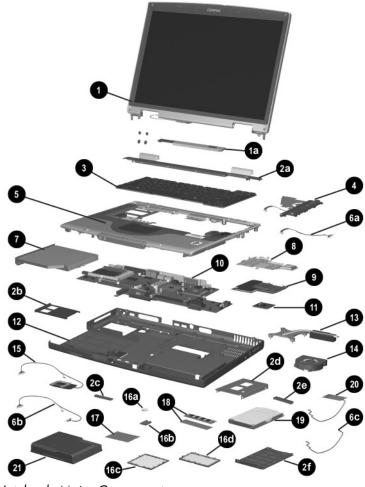
3.1 Serial Number Location

When ordering parts or requesting information, provide the notebook serial number and model number located on the bottom of the notebook.



Serial Number Location

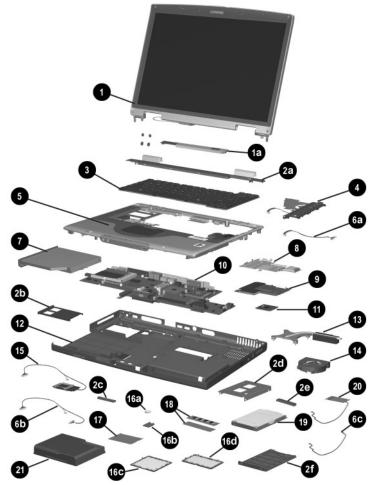
3.2 Notebook Major Components



Notebook Major Components

	Spare Parts: Notebook Major Compon	ents
Item	Description	Spare Part Number
1	Display assemblies	
	With carbon finish for use with HP Compaq nx7000) models
	15.4-inch, WUXGA 15.4-inch, WSXGA+ 15.4-inch, WXGA	337006-001 337003-001 337008-001
	With silver finish for use with Compaq Presario X10	000 models
	15.4-inch, WUXGA 15.4-inch, WSXGA+ 15.4-inch, WXGA	337005-001 337004-001 337007-001
1a	Display inverter (includes four display rubber screw covers)	336994-001
	Miscellaneous Plastics Kits	
	Contains parts with carbon finish for use with HP Compaq nx7000 models	338133-001
	Contains parts with silver finish for use with Compaq Presario X1000 models	337009-001
2a 2b 2c 2d 2e 2f	Include: Switch cover PC Card slot space saver Docking connector cover Hard drive shield Hard drive connector Hard drive cover Notebook feet (not illustrated)	

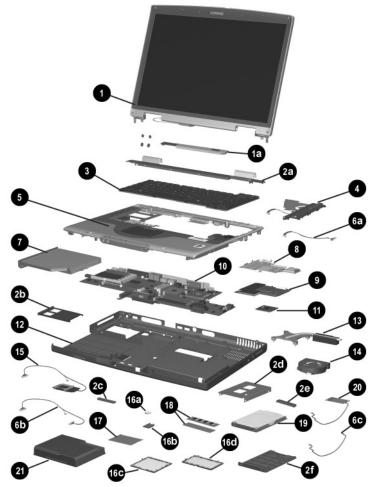
Table 3-1Spare Parts: Notebook Major Components



Notebook Major Components

Item	Description			Spare Part Number
3	Keyboards			
	Belgium Denmark France French Canada Germany International Italy Japan Korea	337016-181 337016-081 337016-051 337016-121 337016-041 337016-B31 337016-061 337016-291 337016-AD1	Norway Portugal Saudi Arabia Spain Switzerland Taiwan Thailand United Kingdom United States	337016-091 337016-131 337016-071 337016-071 337016-111 337016-AB1 337016-281 337016-031 337016-001
4	Speaker cover			336979-001
	Left and right s	peakers (not illu	ustrated)	337015-001
5	Top cover (inclu	ides TouchPad a	and TouchPad shield)	336983-001
	Miscellaneous	Cable Kit, inclue	des	336973-001
6a 6b 6c	Speaker cover SD Card slot b Modem board	oard cable		
7	Optical drives			
	24X Max DVD 8X Max DVD-I 24X Max CD-I	ROM drive	combination drive	336987-001 336986-001 336985-001
8	VGA board shie	d (includes the	rmal pads)	337013-001

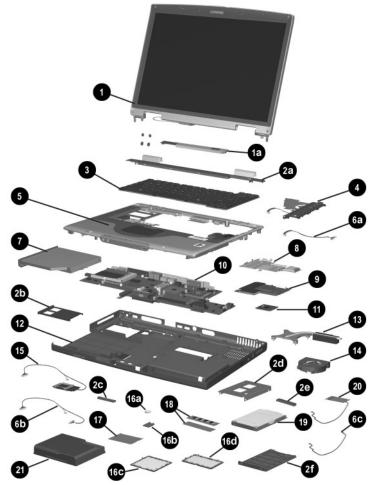
Table 3-1Spare Parts: Notebook Major Components (Continued)



Notebook Major Components

Description	Spare Part Number
VGA boards (includes thermal pads)	
ATI Mobility Radeon 9200 with 64 MB video memory	336970-001
ATI Mobility Radeon 9200 with 32 MB	336969-001
ATI Mobility Radeon 7500c with 32 MB video memory	336968-001
System board (includes thermal pads)	336964-001
PC Card assembly (not illustrated)	337014-001
Processors (include thermal pads)	
Intel Pentium-M 1.6 GHz	337011-001
	337023-001 337024-001
Intel Pentium-M 1.3 GHz	337010-001
Base enclosure (includes infrared lens)	336960-001
Left and right wireless antenna with cables (not illustrated)	336959-001
Heat sink with fan	337000-001
Thermal pad (not illustrated)	337001-001
Fan	336993-001
SD Card slot board with cable	336963-001
	VGA boards (includes thermal pads) ATI Mobility Radeon 9200 with 64 MB video memory ATI Mobility Radeon 9200 with 32 MB video memory ATI Mobility Radeon 7500c with 32 MB video memory ATI Mobility Radeon 7500c with 32 MB video memory System board (includes thermal pads) PC Card assembly (not illustrated) Processors (include thermal pads) Intel Pentium-M 1.6 GHz Intel Pentium-M 1.5 GHz Intel Pentium-M 1.3 GHz Base enclosure (includes infrared lens) Left and right wireless antenna with cables (not illustrated) Heat sink with fan Thermal pad (not illustrated) Fan

Table 3-1 Spare Parts: Notebook Major Components (Continued)

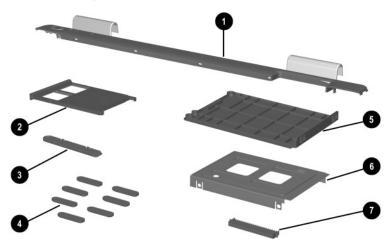


Notebook Major Components

-	are Parts. Notebook major components	,
Item	Description	Spare Part Number
	Miscellaneous Doors/Covers Kit, includes:	336984-001
16a	RTC battery	
16b	RTC battery cover	
16c	Mini PCI compartment cover	
16d	Memory expansion compartment cover	
17	Mini PCI communications boards	
	Mini PCI 802.11b wireless LAN	336976-001
	Mini PCI 802.11b wireless LAN	336977-001
	Mini PCI Bluethumb wireless LAN	338134-001
18	Memory expansion boards	
	1024 MB DDR	336909-001
	512 MB DDR	336998-001
	256 MB DDR	336997-001
	128 MB DDR	336996-001
19	Hard drives (hard drive cover, shield, and connecto hard drive and in Miscellaneous Plastics Kits)	r included with
	80 GB (4200 RPM)	336992-001
	60 GB (5400 RPM)	336991-001
	60 GB (4200 RPM)	336990-001
	40 GB (4200 RPM)	336989-001
20	Modem board with cable	336999-001
21	Battery pack, 8 cell, 4.4 wH	336962-001

Table 3-1 Spare Parts: Notebook Major Components (Continued)

3.3 Miscellaneous Plastics Kit Components



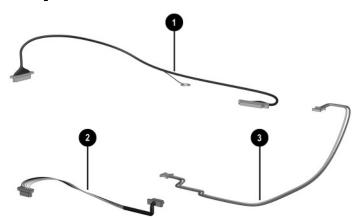
Miscellaneous Plastics Kit Components

Table 3-2 Miscellaneous Plastics Kit Components Spare Part Number 338133-001 (contains parts with carbon finish for use with HP Compaq nx7000 models)

Spare Part Number 337009-001 (contains parts with silver finish for use with Compaq Presario X1000 models)

Item	Description
1	Switch cover
2	PC Card slot space saver
3	Docking connector cover
4	Notebook feet (7)
5	Hard drive cover
6	Hard drive shield
7	Hard drive connector

3.4 Miscellaneous Cable Kit Components

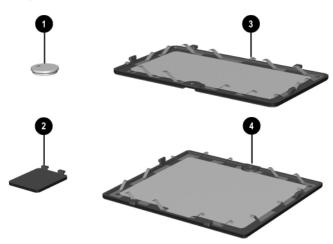


Miscellaneous Cable Kit Components

Table 3-3 Miscellaneous Cable Kit Components Spare Part Number 336973-001

ltem	Description
1	SD Card slot board cable
2	Speaker cover cable
3	Modem cable

3.5 Miscellaneous Doors/Covers Kit Components

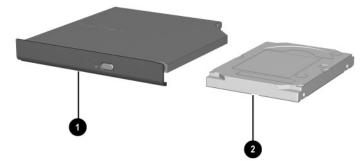


Miscellaneous Doors/Covers Kit Components

Table 3-4Miscellaneous Doors/Covers Kit ComponentsSpare Part Number 336984-001

Item	Description
1	RTC battery
2	RTC battery cover
3	Memory expansion compartment cover
4	Mini PCI compartment cover

3.6 Mass Storage Devices



Mass Storage Devices

Table 3-5 Mass Storage Devices Spare Part Number Information

Item	Description	Spare Part Number
1	Optical drives	
	24X Max DVD-ROM/CD-RW combination drive 8X Max DVD-ROM drive 24X Max CD-ROM drive	336987-001 336986-001 336985-001
2	Hard drives (include hard drive bezel and frame)	
	80 GB (4200 RPM) 60 GB (5400 RPM) 60 GB (4200 RPM) 40 GB (4200 RPM)	336992-001 336991-001 336990-001 336989-001

3.7 Miscellaneous

Table 3-6 Spare Parts: Miscellaneous (not illustrated)				
Description			Spare Part Number	
AC adapter			338136-001	
Logo Kits				
	Compaq nx7000 nc paq Presario X100		336995-001 338135-001	
Power cord, 3-wire				
Australia Denmark Europe/Middle East/Africa Italy	246959-011 246959-081 246959-021 246959-061	Japan Korea Switzerland United Kingdom United States	246959-291 246959-AD1 246959-AG1 246959-031 246959-001	
Screw Kit (includes Appendix C, "Screw screw specification	ew Listing," for mor		337012-001	
 Phillips M2.5×15.0 screw Phillips M2.5×7.0 screw Phillips M2.5×5.0 screw Phillips M2.5×5.0 screw Spring-loaded Phillips M2.0×9.0 screw 				

4

Removal and Replacement Preliminaries

This chapter provides essential information for proper and safe removal and replacement service.

4.1 Tools Required

You will need the following tools to complete the removal and replacement procedures:

- Magnetic screwdriver
- Phillips P0 screwdriver
- Flat-bladed tool
- Tool kit (includes connector removal tool, loopback plugs, and case utility tool)

4.2 Service Considerations

The following sections include some of the considerations that you should keep in mind during disassembly and assembly procedures.



As you remove each subassembly from the notebook, place the subassembly (and all accompanying screws) away from the work area to prevent damage.

Plastic Parts

Using excessive force during disassembly and reassembly can damage plastic parts. Use care when handling the plastic parts. Apply pressure only at the points designated in the maintenance instructions.

Cables and Connectors

Cables must be handled with extreme care to avoid damage. Apply only the tension required to unseat or seat the cables during removal and insertion. Handle cables by the connector whenever possible. In all cases, avoid bending, twisting, or tearing cables. Ensure that cables are routed in such a way that they cannot be caught or snagged by parts being removed or replaced. Handle flex cables with extreme care; these cables tear easily.

CAUTION: When servicing the notebook, ensure that cables are placed in their proper locations during the reassembly process. Improper cable placement can damage the notebook.

4.3 Preventing Damage to Removable Drives

Removable drives are fragile components that must be handled with care. To prevent damage to the notebook, damage to a removable drive, or loss of information, observe the following precautions:

- Before removing or inserting a hard drive, shut down the notebook. If you are unsure whether the notebook is off or in Hibernation, turn the notebook on, then shut it down.
- Before removing a diskette drive or optical drive, ensure that a diskette or disc is not in the drive. Ensure that the optical drive tray is closed.
- Before handling a drive, ensure that you are discharged of static electricity. While handling a drive, avoid touching the connector.
- Handle drives on surfaces that have at least one inch of shock-proof foam.
- Avoid dropping drives from any height onto any surface.
- After removing a hard drive, CD-ROM drive, or a diskette drive, place it in a static-proof bag.
- Avoid exposing a hard drive to products that have magnetic fields, such as monitors or speakers.
- Avoid exposing a drive to temperature extremes or liquids.
- If a drive must be mailed, place the drive in a bubble pack mailer or other suitable form of protective packaging and label the package "Fragile: Handle With Care."

4.4 Preventing Electrostatic Damage

Many electronic components are sensitive to electrostatic discharge (ESD). Circuitry design and structure determine the degree of sensitivity. Networks built into many integrated circuits provide some protection, but in many cases the discharge contains enough power to alter device parameters or melt silicon junctions.

A sudden discharge of static electricity from a finger or other conductor can destroy static-sensitive devices or microcircuitry. Often the spark is neither felt nor heard, but damage occurs.

An electronic device exposed to electrostatic discharge might not be affected at all and can work perfectly throughout a normal cycle. Or the device might function normally for a while, then degrade in the internal layers, reducing its life expectancy.

4.5 Packaging and Transporting Precautions

Use the following grounding precautions when packaging and transporting equipment:

- To avoid hand contact, transport products in static-safe containers, such as tubes, bags, or boxes.
- Protect all electrostatic-sensitive parts and assemblies with conductive or approved containers or packaging.
- Keep electrostatic-sensitive parts in their containers until the parts arrive at static-free workstations.
- Place items on a grounded surface before removing items from their containers.
- Always be properly grounded when touching a sensitive component or assembly.

- Store reusable electrostatic-sensitive parts from assemblies in protective packaging or nonconductive foam.
- Use transporters and conveyors made of antistatic belts and roller bushings. Ensure that mechanized equipment used for moving materials is wired to ground and that proper materials are selected to avoid static charging. When grounding is not possible, use an ionizer to dissipate electric charges.

4.6 Workstation Precautions

Use the following grounding precautions at workstations:

- Cover the workstation with approved static-shielding material (refer to Table 4-2).
- Use a wrist strap connected to a properly grounded work surface and use properly grounded tools and equipment.
- Use conductive field service tools, such as cutters, screwdrivers, and vacuums.
- When using fixtures that must directly contact dissipative surfaces, only use fixtures made of static-safe materials.
- Keep the work area free of nonconductive materials, such as ordinary plastic assembly aids and Styrofoam.
- Handle electrostatic-sensitive components, parts, and assemblies by the case or PCM laminate. Handle these items only at static-free workstations.
- Avoid contact with pins, leads, or circuitry.
- Turn off power and input signals before inserting or removing connectors or test equipment.

4.7 Grounding Equipment and Methods

Grounding equipment must include either a wrist strap or a foot strap at a grounded workstation.

- When seated, wear a wrist strap connected to a grounded system. Wrist straps are flexible straps with a minimum of one megohm ±10% resistance in the ground cords. To provide proper ground, wear a strap snugly against the skin at all times. On grounded mats with banana-plug connectors, connect a wrist strap with alligator clips.
- When standing, use foot straps and a grounded floor mat. Foot straps (heel, toe, or boot straps) can be used at standing workstations and are compatible with most types of shoes or boots. On conductive floors or dissipative floor mats, use foot straps on both feet with a minimum of one-megohm resistance between the operator and ground. To be effective, the conductive strips must be worn in contact with the skin.

Other grounding equipment recommended for use in preventing electrostatic damage includes:

- Antistatic tape
- Antistatic smocks, aprons, and sleeve protectors
- Conductive bins and other assembly or soldering aids
- Nonconductive foam
- Conductive tabletop workstations with ground cords of one-megohm resistance
- Static-dissipative tables or floor mats with hard ties to the ground
- Field service kits
- Static awareness labels
- Material-handling packages
- Nonconductive plastic bags, tubes, or boxes

Metal tote boxes

Electrostatic voltage levels and protective materials

Table 4-1 shows how humidity affects the electrostatic voltage levels generated by different activities.

Relative Humidity			dity
Event	10%	40%	55%
Walking across carpet	35,000 V	15,000 V	7,500 V
Walking across vinyl floor	12,000 V	5,000 V	3,000 V
Motions of bench worker	6,000 V	800 V	400 V
Removing DIPS from plastic tube	2,000 V	700 V	400 V
Removing DIPS from vinyl tray	11,500 V	4,000 V	2,000 V
Removing DIPS from Styrofoam	14,500 V	5,000 V	3,500 V
Removing bubble pack from PCB	26,500 V	20,000 V	7,000 V
Packing PCBs in foam-lined box	21,000 V	11,000 V	5,000 V
A product can be degraded by as little as 700 V.			

Table 4-1Typical Electrostatic Voltage Levels

Table 4-2 lists the shielding protection provided by antistatic bags and floor mats.

Static-Shielding Materials				
Material Use Voltage Protection Level				
Antistatic plastic	Bags	1,500 V		
Carbon-loaded plastic Floor mats 7,500 V				
Metallized laminate	Floor mats	5,000 V		

Table 1.2

5

Removal and Replacement Procedures

This chapter provides removal and replacement procedures.

There are 48 Phillips screws, in seven different sizes, that must be removed, replaced, and/or loosened when servicing the notebook. Make special note of each screw size and location during removal and replacement.

Refer to Appendix C, "Screw Listing," for detailed information on screw sizes, locations, and usage.

5.1 Serial Number

Report the notebook serial number to HP when requesting information or ordering spare parts. The serial number is located on the bottom of the notebook.



Serial Number Location

5.2 Disassembly Sequence Chart

Use the following chart to determine the section number to be referenced when removing notebook components.

Section	Description	# of Screws Removed
5.3	Preparing the notebook for disassen	nbly
	Battery pack	0
	Hard drive	2
	Hard drive cover and shield	4
5.4	Notebook feet	0
5.5	Memory expansion board	1
5.6	Mini PCI communications board	1
5.7	RTC battery	0
5.8	Optical drive	1
5.9	Keyboard	2
5.10	Switch cover	0
5.11	Speaker cover	4
5.12	Fan	1
5.13	Heat sink	4
5.14	Processor	0
5.15	Display assembly	7
5.16	Top cover	16
5.17	SD Card slot board and cable	2
5.18	VGA board and shield	2
5.19	Modem board and cable	0
5.20	System board	1

Disassembly Sequence Chart

5.3 Preparing the Notebook for Disassembly

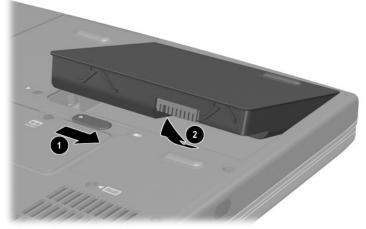
Perform the following steps before disassembling the notebook:

- 1. Turn off the notebook.
- 2. Disconnect the AC adapter and all external devices.

Spare Part Number Information		
Battery pack, 8 cell, 4.4 wH	336962-001	

- 3. Remove the battery pack by following these steps:
 - a. Turn the notebook bottom side up with the rear panel facing forward.

- b. Slide and hold **1** the battery release latch to the right. The front edge of the battery pack releases from the notebook.
- c. Lift the front edge of the battery pack up and swing it back **2**.



Removing the Battery Pack

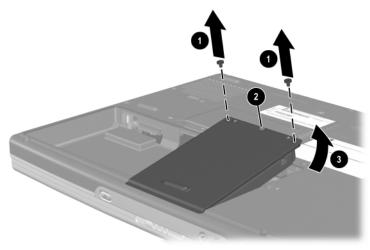
d. Remove the battery pack.

Reverse the above procedure to install the battery pack.

Spare Pa	rt Number	Information
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80 GB hard drive (4200 RPM)	336992-001
60 GB hard drive (5400 RPM)	336991-001
60 GB hard drive (4200 RPM)	336990-001
40 GB hard drive (4200 RPM)	336989-001

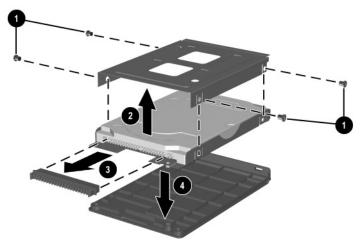
- 4. Remove the hard drive by following these steps:
 - a. Turn the notebook bottom side up with the front facing forward.
 - b. Remove the two PM2.5 \times 7.0 screws **1** that secure the hard drive to the notebook.
 - c. Use the notch **2** on the hard drive cover to lift the rear edge of the hard drive up and swing it forward **3**.



Removing the Hard Drive

d. Remove the hard drive.

- e. Remove the four PM2.5 \times 3.5 screws **①** that secure the hard drive to the hard drive cover and shield.
- f. Remove the hard drive shield **2** and connector **3** from the hard drive.
- g. Separate the hard drive from the hard drive cover **④**.



Removing the Hard Drive from the Hard Drive Cover

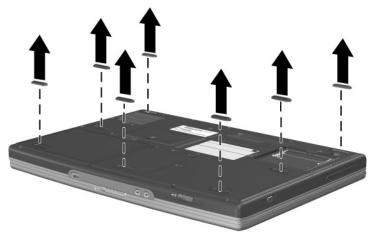
CAUTION: The hard drive cover should only be removed if it is damaged and must be replaced. Unnecessarily removing the cover can result in damage to the cover and hard drive and loss of information.

The hard drive cover, shield, and connector are included with the hard drive and also in the Miscellaneous Plastics Kits, spare part number 338133-001 for HP Compaq nx7000 models, and spare part number 337009-001 for Compaq Presario X1000 models.

Reverse the above procedure to install the hard drive.

5.4 Notebook Feet

The notebook feet are adhesive-backed rubber pads, and are included in the Miscellaneous Plastics Kits, spare part number 338133-001 for HP Compaq nx7000 models, and spare part number 337009-001 for Compaq Presario X1000 models. The notebook feet attach to the base enclosure as indicated in the following illustration.



Replacing the Notebook Feet

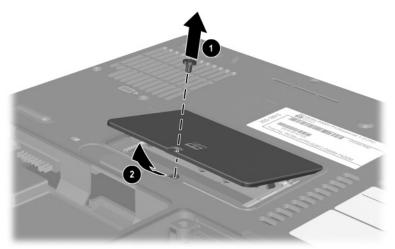
5.5 Memory Expansion Board

Spare Part Number Information

1024 MB DDR memory expansion board	336909-001
512 MB DDR memory expansion board	336998-001
256 MB DDR memory expansion board	336997-001
128 MB DDR memory expansion board	336996-001

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Turn the notebook bottom side up with the front facing forward.

- 3. Remove the PM2.5×5.0 screw **①** that secures the memory expansion compartment cover to the notebook.
- 4. Lift the front edge of the cover up **2** and swing it back **3**.

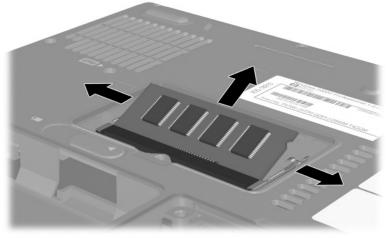


Removing the Memory Expansion Compartment Cover

5. Remove the cover.

The memory expansion compartment cover is included in the Miscellaneous Doors/Covers Kit, spare part number 336984-001.

- 6. Spread the retaining tabs ① that secure the memory expansion board to the socket. The board rises up at a 45-degree angle.
- 7. Pull the board away from the socket at a 45-degree angle @.



Removing the Memory Expansion Board

Reverse the above procedure to install a memory expansion board.

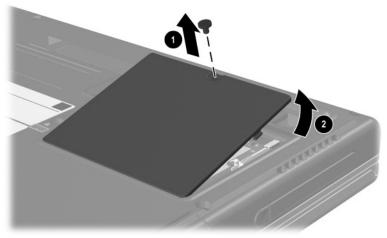
5.6 Mini PCI Communications Board

Spare Part Number Information

Mini PCI 802.11b wireless LAN	336976-001
Mini PCI 802.11b wireless LAN	336977-001
Mini PCI Bluethumb wireless LAN	338134-001

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Turn the notebook bottom side up with the front facing forward.

- 3. Remove the PM2.5×5.0 screw **①** that secures the mini PCI compartment cover to the notebook.
- 4. Lift the rear edge of the cover up **2** and swing it forward **3**.



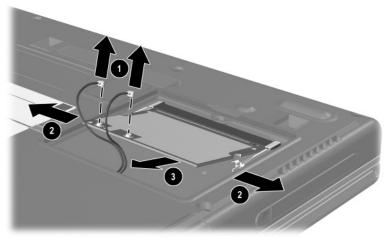
Removing the Mini PCI Compartment Cover

5. Remove the cover.



The mini PCI compartment cover is included in the Miscellaneous Doors/Covers Kit, spare part number 336984-001.

- 6. Disconnect the two antenna cables from the terminals on the mini PCI communications board **①**. Note that the longer of the two cables should be connected to the left antenna terminal (marked "AUX") and the shorter cable should be connected to the right terminal (marked "MAIN").
- 7. Spread the retaining tabs 2 that secure the memory expansion board to the socket. The board rises up at a 45-degree angle.
- 8. Pull the board away from the socket at a 45-degree angle **③**.



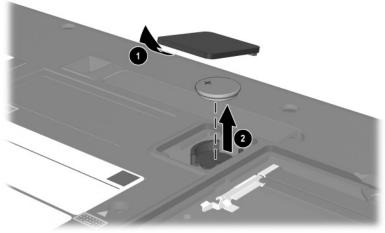
Removing the Mini PCI Communications Board

Reverse the above procedure to install a mini PCI communications board.

5.7 RTC Battery

The RTC battery and RTC battery cover are included in the Miscellaneous Doors/Covers Kit, spare part number 336984-001.

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Turn the notebook bottom side up with the front facing forward.
- 3. Insert a flat-bladed tool into the notch **1** on the front edge of the RTC battery cover and separate the front edge of the cover from the notebook.
- 4. Remove the RTC battery from the socket on the system board **2**.



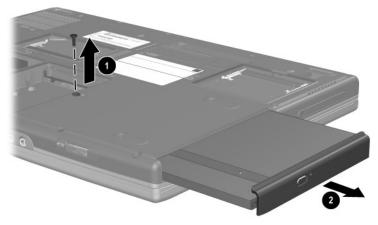
Removing the RTC battery Reverse the above procedure to install an RTC battery.

5.8 Optical Drive

Spare Part Number Information

24X Max DVD-ROM/CD-RW combination drive	336987-001
8X Max DVD-ROM drive	336986-001
	000005 001
24X Max CD-ROM drive	336985-001

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Turn the notebook bottom side up with the front facing forward.
- 3. Remove the PM2.5×7.0 screw **①** that secures the optical drive to the notebook.
- 4. Insert a slender tool into the slot in the hard drive bay and push to the right to disengage the optical drive from the notebook ②.



Removing the Optical Drive

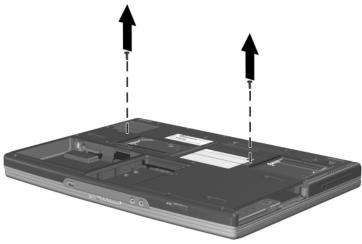
5. Remove the optical drive.

Reverse the above procedure to install an optical drive.

Spare Part Number Information				
Belgium	337016-181	Norway	337016-091	
Denmark	337016-081	Portugal	337016-131	
France	337016-051	Saudi Arabia	337016-171	
French Canada	337016-121	Spain	337016-071	
Germany	337016-041	Switzerland	337016-111	
International	337016-B31	Taiwan	337016-AB1	
Italy	337016-061	Thailand	337016-281	
Japan	337016-291	United Kingdom	337016-031	
Korea	337016-AD1	United States	337016-001	

5.9 Keyboard

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Turn the notebook bottom side up with the front facing forward.
- 3. Remove the two PM2.5×15.0 screws that secure the keyboard to the base enclosure.



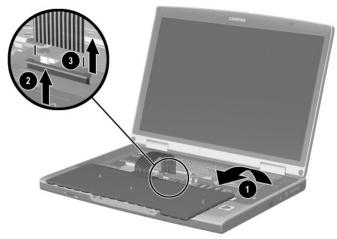
Removing the Keyboard Screws

- 4. Turn the notebook top side up with the front facing forward.
- 5. Open the notebook.
- 6. Slide the four notches on the top edge of the keyboard forward.



Releasing the Keyboard

- 7. Lift the rear edge of the keyboard, swing it up and forward **①**, and rest it on the top cover.
- 8. Release the ZIF connector 2 to which the keyboard cable is attached and disconnect the keyboard cable 3 from the system board.



Disconnecting the Keyboard Cable

9. Remove the keyboard.

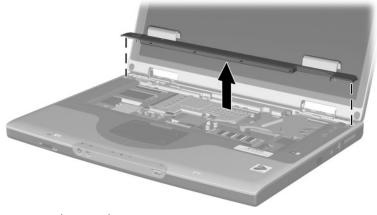
Reverse the above procedure to install the keyboard.

After the keyboard is removed, the internal memory expansion board connector is accessible. Refer to the "Memory Expansion Board" section for instructions on removing the internal memory expansion board.

5.10 Switch Cover

The switch cover is included in the Miscellaneous Plastics Kits, spare part number 338133-001 for HP Compaq nx7000 models, and spare part number 337009-001 for Compaq Presario X1000 models.

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Remove the keyboard (Section 5.9).
- 3. Insert a flat-bladed tool under the outside edges of the hinge cover areas and lift up to disengage the left and right sides of the cover from the notebook.
- 4. Remove the switch cover.



Removing the Switch Cover

Reverse the above procedure to install the switch cover.

5.11 Speaker Cover

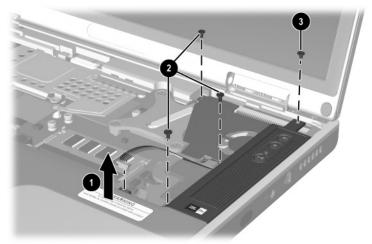
Spare Part Number Information

Speaker cover with cable

336979-001

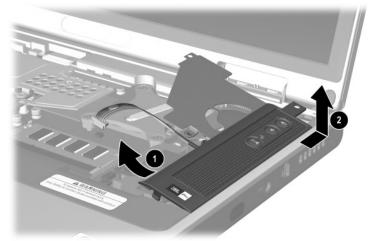
The speaker cover cable is also included in the Miscellaneous Cable Kit, spare part number 336973-001.

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Remove the keyboard (Section 5.9).
- 3. Remove the switch cover (Section 5.10).
- 4. Disconnect the audio cable \bullet from the system board.
- 5. Remove the three PM2.5×5.0 screws ② and the PM2.5×3.0 screw ③ that secure the speaker cover to the notebook.



Removing the Speaker Cover Screws

- 6. Lift the left side of the speaker cover shield and swing it up and slightly to the right **●**.
- 7. Slide the speaker cover back ② to disengage it from the notebook.
- 8. Remove the speaker cover.



Removing the Speaker Cover

Reverse the above procedure to install the speaker cover.

5.12 Fan

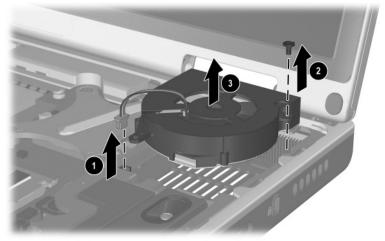
Spare Part Number Information

Fan

336993-001

The fan is also included with the heat sink, spare part number 337000-001.

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Remove the keyboard (Section 5.9).
- 3. Remove the switch cover (Section 5.10).
- 4. Remove the speaker cover (Section 5.11).
- 5. Disconnect the fan cable \bullet from the system board.
- 6. Remove the PM2.5×5.0 screw ② that secures the fan to the base enclosure.
- 7. Remove the fan **③**.



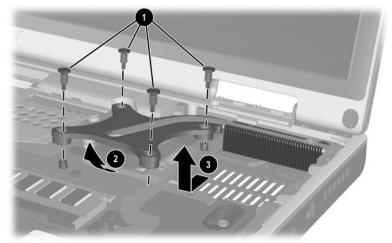
Removing the Fan Reverse the above procedure to install the fan.

5.13 Heat Sink

Spare Part Number Information

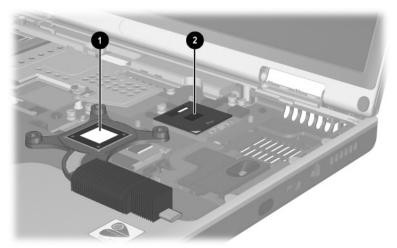
Heat sink with fan	337000-001
Thermal pad	337001-001

- 1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:
 - □ Keyboard (Section 5.9)
 - $\Box \quad \text{Switch cover (Section 5.10)}$
 - □ Speaker cover (Section 5.11)
 - $\Box \quad Fan (Section 5.12)$
- 2. Remove the four PM2.0×9.0 spring-loaded shoulder screws **①** that secure the heat sink to the notebook.
- 3. Lift the front edge of the heat sink ② and slide the heat sink out of the notebook at an angle ③.



Removing the Heat Sink

Carefully clean any thermal grease residue from the heat sink **1** and processor surfaces **2** each time you remove the heat sink. Apply new thermal grease to both surfaces.



Removing the Thermal Grease From the Heat Sink and Processor Reverse the above procedure to install the heat sink.

5.14 Processor

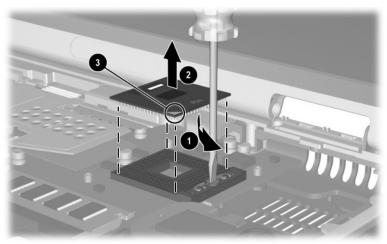
Spare Part Number Information

Intel Pentium-M 1.6-GHz processor	337011-001
Intel Pentium-M 1.5-GHz processor	337023-001
Intel Pentium-M 1.4-GHz processor	337024-001
Intel Pentium-M 1.3-GHz processor	337010-001

- 1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:
 - □ Keyboard (Section 5.9)
 - \Box Switch cover (Section 5.10)
 - □ Speaker cover (Section 5.11)
 - $\Box \quad \text{Fan (Section 5.12)}$
 - \Box Heat sink (Section 5.13)

- 2. Use a flat-bladed tool to turn the processor locking screw **1** one-quarter turn counterclockwise.
- 3. Lift the processor straight up **2** and remove it.

Note that the gold triangle ③ should be in the lower right corner when installing the processor.



Removing the Processor

Reverse the above procedure to install the processor.

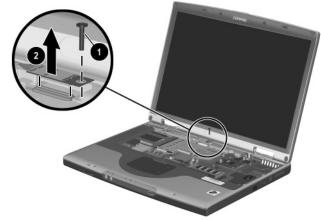
5.15 Display Assembly

Spare Part Number Information

With carbon finish for use with HP Compaq nx7000 models

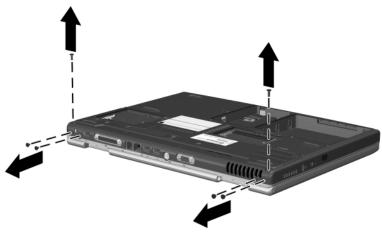
15.4-inch, WUXGA	337006-001
15.4-inch, WSXGA+	337003-001
15.4-inch, WXGA	337008-001
With silver finish for use with Compaq Presario X1000 models	
15.4-inch, WUXGA	337005-001
15.4-inch, WSXGA+	337004-001
15.4-inch, WXGA	337007-001
Display inverter (includes display rubber screw covers)	336994-001

- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Remove the keyboard (Section 5.9).
- 3. Remove the switch cover (Section 5.10).
- 4. Remove the PM2.5×15.0 screw ① that secures the display cable to the base enclosure.
- 5. Disconnect the display video cable 2 from the system board.



Disconnecting the Display Cable

- 6. Close the notebook and turn the notebook bottom side up with the rear panel facing forward.
- 7. Remove the six PM2.5×7.0 screws that secure the display assembly to the base enclosure.



Removing the Display Screws

- 8. Turn the notebook top side up with the front facing forward.
- 9. Open the display to the fully upright position.
- 10. Lift the display assembly straight up and remove it.



Removing the Display Assembly

Reverse the above procedure to install the display assembly.

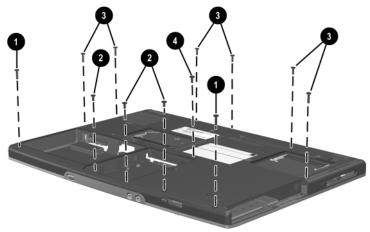
5.16 Top Cover

Spare Part Number Information

Top cover (includes TouchPad and TouchPad shield)	336983-001
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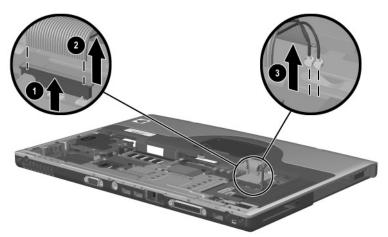
- 1. Prepare the notebook for disassembly (Section 5.3).
- 2. Disconnect the wireless antenna cables from the mini PCI communications board (Section 5.6).
- 3. Remove the following components:
 - □ Optical drive (Section 5.8)
 - □ Keyboard (Section 5.9)
 - $\Box \quad \text{Switch cover (Section 5.10)}$
 - $\Box \quad \text{Speaker cover (Section 5.11)}$
 - □ Display assembly (Section 5.15)
- 4. Turn the notebook bottom side up with the front facing forward.

- 5. Remove the following screws:
 - □ Two PM2.5×7.0 screws in the front corners of the notebook ●
 - □ Two PM2.5×5.0 screws in the hard drive bay and one PM2.5×5.0 screw on the right side of the hard drive bay ②
 - $\Box \quad Six PM2.5 \times 15.0 \text{ screws } \textcircled{\textbf{0}}$
 - \Box One PM2.5×7.0 screw **4** behind the hard drive bay



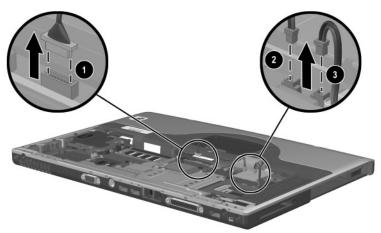
Removing the Top Cover Screws

- 6. Turn the notebook top side up with the rear panel facing forward.
- 7. Release the ZIF connector to which the TouchPad cable is attached and disconnect the TouchPad cable ❷ from the system board.
- 8. Route the two antenna cables ③ out of the hole in the system board.



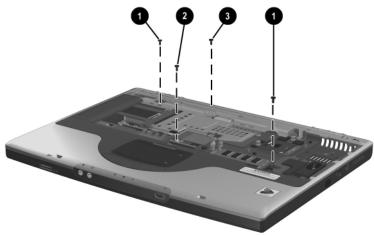
Disconnecting the TouchPad Cable and Routing the Wireless Antenna Cables

- 9. If connected, disconnect the Bluethumb wireless module cable **1** from the system board.
- 10. Disconnect the left **2** and right speaker cables **3** from the system board.



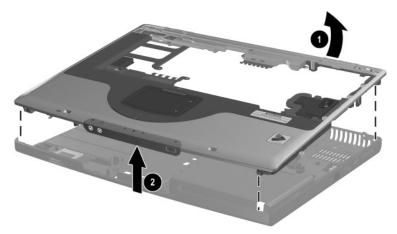
Disconnecting the Bluethumb Wireless Module and Speaker Cables

- 11. Remove the following screws:
 - □ Two PM2.5×7.0 screws that secure the top cover to the base enclosure
 - □ One PM2.0×3.0 screw ② that secures the top cover and modem to the base enclosure
 - □ One PM2.5×5.0 screw ③ that secures the top cover to the base enclosure above the USB connector



Removing the Top Cover Screws

- 12. Position the notebook so the front faces forward.
- 13. Lift the back edge of the top cover ① and swing it forward ② to disengage it from the base enclosure.
- 14. Remove the top cover.



Removing the Top Cover Reverse the above procedure to install the top cover.

5.17 SD Card Slot Board and Cable

Spare Part Number Information

SD Card slot board with cable

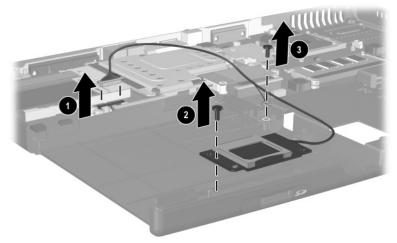
336963-001

The SD Card slot board cable is also included in the Miscellaneous Cable Kit, spare part number 336973-001.



- 1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:
 - □ Mini PCI communications board (Section 5.6)
 - □ Optical drive (Section 5.8)
 - □ Keyboard (Section 5.9)
 - $\Box \quad \text{Switch cover (Section 5.10)}$
 - □ Speaker cover (Section 5.11)
 - □ Display assembly (Section 5.15)
 - **\Box** Top cover (Section 5.16)

- 2. Disconnect the SD Card slot board cable **1** from the system board.
- 3. Remove the PM2.5×5.0 screw ② that secures the SD Card slot board to the notebook.
- 4. Remove the PM2.5×5.0 screw ③ that secures the SD Card slot board cable ground loop to the notebook.
- 5. Remove the SD Card slot board and cable.



Removing the SD Card Slot Board and Cable

Reverse the above procedure to install the SD Card slot board and cable.

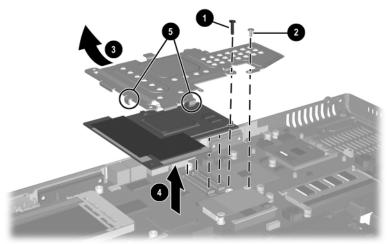
5.18 VGA Board and Shield

Spare Part Number Information		
VGA boards (include thermal pads)		
ATI Mobility Radeon 9200 with 64 MB video memory	336970-001	
ATI Mobility Radeon 9200 with 32 MB video memory	336969-001	
ATI Mobility Radeon 7500c with 32 MB video memory	336968-001	
VGA board shield (includes thermal pads)	337017-001	

1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:

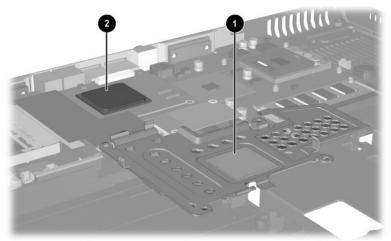
- □ Mini PCI communications board (Section 5.6)
- **Optical drive (Section 5.8)**
- □ Keyboard (Section 5.9)
- $\Box \quad \text{Switch cover (Section 5.10)}$
- □ Speaker cover (Section 5.11)
- □ Display assembly (Section 5.12)
- $\Box \quad \text{Top cover (Section 5.16)}$

- 2. Remove the PM2.5×15.0 and PM2.0×3.0 screws that secure the VGA board shield to the base enclosure.
- 3. Lift the upper left corner of the VGA board ③ to disconnect it from the system board.
- 4. Remove the VGA board and shield **④**.
- 5. Disengage the shield clips () to remove the VGA board from the shield.



Removing the VGA Board and Shield

6. The VGA shield **1** and board **2** contain thermal pads that assist in cooling the notebook. Inspect these pads and replace if necessary each time the shield is removed.



Replacing the Thermal Pads on the VGA Board and Shield

Reverse the above procedure to install the VGA board and shield.

5.19 Modem and Cable

Spare Part Number Information

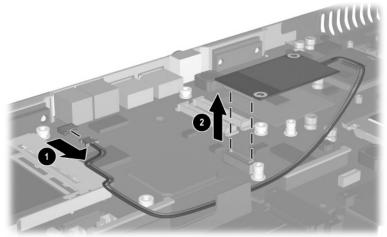
Modem board with cable

336999-001

The modem board cable is also included in the Miscellaneous Cable Kit, spare part number 336973-001.

- 1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:
 - □ Mini PCI communications board (Section 5.6)
 - □ Optical drive (Section 5.8)
 - □ Keyboard (Section 5.9)
 - $\Box \quad \text{Switch cover (Section 5.10)}$

- □ Speaker cover (Section 5.11)
- □ Display assembly (Section 5.15)
- **\Box** Top cover (Section 5.16)
- □ VGA board and shield (Section 5.18)
- 2. Disconnect the modem cable **1** from the system board.
- 3. Lift the left side of the modem board **2** to disconnect it from the system board.
- 4. Remove the modem board.



Removing the Modem Board and Cable Reverse the above procedure to install the modem and cable.

5.20 System Board

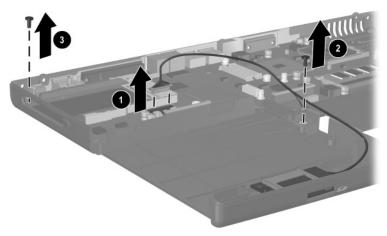
Spare Part Number Information

System board (includes thermal pads)	336964-001
PC Card assembly (removal not documented)	337014-001

When replacing the system board, ensure that the following components are removed from the defective system board and installed on the replacement system board:

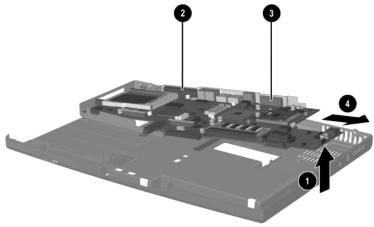
- Memory expansion boards (Section 5.5)
- Mini PCI communications board (Section 5.6)
- RTC battery (Section 5.7)
- Processor (Section 5.14)
- VGA board and shield (Section 5.18)
- Modem and modem cable (Section 5.19)
 - 1. Prepare the notebook for disassembly (Section 5.3) and remove the following components:
 - □ Optical drive (Section 5.8)
 - □ Keyboard (Section 5.9)
 - \Box Switch cover (Section 5.10)
 - □ Speaker cover (Section 5.11)
 - □ Display assembly (Section 5.12)
 - $\Box \quad \text{Top cover (Section 5.16)}$

- 2. Disconnect the SD Card slot board cable **1** from the system board.
- 3. Remove the PM2.5×5.0 screw ② that secures the SD Card slot board cable ground loop to the base enclosure and the PM2.5×5.0 screw ③ that secures the system board to the base enclosure.



Removing the System Board Screws

- 4. Lift the right side of the system board approximately 1 inch **1**. If necessary, flex the back edge of the base enclosure out so the parallel **2** and serial connectors **3** can clear the base enclosure.
- 5. Slide the system board to the right an angle **④**.
- 6. Remove the system board.



Removing the System Board

Reverse the above procedure to install the system board.

6

Specifications

This chapter provides physical and performance specifications.

	Table 6-1 Notebook	
Dimensions		
Height Width Depth	3.45 cm 25.40 cm 35.56 cm	1.4 in 10.0 in 14.0 in
Weight (varies by configu	iration)	
	2.95 kg	6.5 lbs
Stand-alone power requ	irements	
Nominal operating voltage	14.4 VDC	
Average operating power	15.8 W	
Peak operating power Power in Standby mode	38.0 W < 800 mW	
Power in Hibernation mode	< 100 mW	
Temperature		
Operating Nonoperating	10° to 35° C -10° to 60° C	50° to 95° F 14° to 140° F
Relative humidity (noncondensing)		
Operating Nonoperating	10% to 90% 5% to 90%, 38.7° C (101.6° F) maximum wet bulb temperature	

Table 6-1 Notebook *(Continued)*

	•	/	
Altitude (unpressurized)			
Operating (14.7 to 10.1 psia)	0 to 3,048 m 0 to 10,000 ft		
Nonoperating (14.7 to 4.4 psia)	0 to 9,144 m	0 to 30,000 ft	
Shock			
Operating Nonoperating	10 G, 11 ms, half-sine 60 G, 11 ms, half-sine		
Vibration			
Operating	0.5 G zero-to-peak, 10 to 500 Hz, 0.25 oct/min sweep rate		
Nonoperating	1.0 G zero-to-peak, 10 to 500 Hz, 0.5 oct/min sweep rate		
Applicable product safety standards specify thermal limits for plastic surfaces. The notebook operates well within this range of temperatures.			

Table 6-2		
15.4-inch, Wide UXGA, TFT Display	y	

	, , ,			
Dimensions				
Height	20.7 cm	8.1 in		
Width	33.1 cm	13.0 in		
Diagonal	39.1 cm	15.4 in		
Number of colors	up to 16.8 million	up to 16.8 million		
Contrast ratio	300:1			
Brightness	170 nits typical			
Pixel resolution				
Pitch	0.173 × 0.173 mm			
Format	1920 × 1200			
Configuration	RGB vertical stripe			
Backlight	Edge lit			
Character display	80 × 25			
Viewing angle	+/- 55° degrees horizontal, +/- 45° vertical typical			

Table 6-3		
15.4-inch, Wide SXGA+, TFT Display		

-	-))	
Dimensions		
Height	20.7 cm	8.1 in
Width	33.1 cm	13.0 in
Diagonal	39.1 cm	15.4 in
Number of colors	up to 16.8 million	
Contrast ratio	200:1	
Brightness	180 nits typical	
Pixel resolution		
Pitch	0.197 × 0.197 mm	
Format	1680 × 1050	
Configuration	RGB vertical stripe	
Backlight	Edge lit	
Character display	80 × 25	
Viewing angle	+/- 65° degrees horizontal, +/- 50° vertical typical	

Table 6-4				
15.4-inch,	Wide	XGA+,	TFT	Display

Dimensions				
Height	20.7 cm	8.1 in		
Width	33.1 cm	13.0 in		
Diagonal	39.1 cm	15.4 in		
Number of colors	up to 16.8 million			
Contrast ratio	200:1	200:1		
Brightness	180 nits typical			
Pixel resolution				
Pitch	0.259 × 0.259 mm			
Format	1280 × 800			
Configuration	RGB vertical stripe			
Backlight	Edge lit			
Character display	80 × 25			
Viewing angle	+/- 65° degrees horizontal, +/- 50° vertical typical			

Table 6-5 Hard Drives				
	80 GB	60 GB (5400 rpm)	60 GB (4200 rpm)	40 GB
User capacity per drive ¹	80 GB	60 GB	40 GB	30 GB
Dimensions				
Height Width Weight	9.5 mm 70 mm 99 g	9.5 mm 70 mm 102 g	9.5 mm 70 mm 99 g	9.5 mm 70 mm 99 g
Interface type	ATA-5	ATA-5	ATA-5	ATA-5
Transfer rate				
Synchronous (maximum) Security	100 MB/ sec ATA security	100 MB/ sec ATA security	100 MB/ sec ATA security	100 MB/ sec ATA security
Seek times (typical read, including setting)				
Single track Average Maximum	3 ms 13 ms 24 ms			
Logical blocks ²	156,301,488	117,210,240	78,140,160	58,605,120
Disk rotational speed	4200 rpm	5400 rpm	4200 rpm	4200 rpm
Operating temperature	5° to 55° C (41° to 131° F)			

¹1 GB = 1,073,741,824 bytes.

²Actual drive specifications may differ slightly.

Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details.

Ext	Table 6-6 ernal AC Adapter	
Weight	.304 kg	0.67 lb
Power supply		
Rated input voltage Rated input current Rated frequency	100 to 240 VAC RMS 1.7 A RMS 47 to 63 Hz	
8-cell, Prir	Table 6-7 nary Li ion Battery	Pack
Dimensions		
Height Width Depth Weight	13.4 cm 9.2 cm 1.9 cm .43 kg	5.25 in 3.63 in .75 in .96 lb
Energy		
Voltage Amp-hour capacity Watt-hour capacity	14.8 V 4.4 aH 64 wH	
Temperature		
Operating Nonoperating	0 to 60° C -20 to 60° C	32 to 140° F -4 to 104° F
Recharge time		
System in off mode or Standby System on (depending on system power consumption)	2 to 3 hours 2 to 5 hours	

	le 6-8 D-RW Drive	
Applicable disk	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge	
Center hole diameter	1.5 cm 0.59 in	
Disk diameter	12 cm, 8 cm	
Disk thickness	1.2 mm 0.047 in	
Track pitch	0.74 µm	
Access time		
Random Full stroke	< 150 ms < 225 ms	
Audio output level	Line-out, 0.7 Vrms	
ache buffer 128 KB/s		
Data transfer rate		
CD-R (24X) CD-RW (10X) CD-ROM (24X) DVD (8X) Multiword DMA mode 2	3600 KB/s (150 KB/s at 1X CD rate) 1500 KB/s (150 KB/s at 1X CD rate) 3600 KB/s (150 KB/s at 1X CD rate) 10,800 KB/s (1352 KB/s at 1X DVD rate) 16.6 MB/s	
Startup time	< 15 seconds	
Stop time	me < 6 seconds	

	RW Drive	
Applicable disk	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge	
Center hole diameter	1.5 cm 0.59 in	
Disk diameter	12 cm, 8 cm	
Disk thickness	1.2 mm 0.047 in	
Track pitch	0.74 μm	
Access time		
Random Full stroke	< 150 ms < 225 ms	
Audio output level Line-out, 0.7 Vrms		
Cache buffer 128 KB/s		
Data transfer rate		
CD-R (24X) CD-RW (10X) CD-ROM (24X) DVD (8X) Multiword DMA mode 2	3600 KB/s (150 KB/s at 1X CD rate) 1500 KB/s (150 KB/s at 1X CD rate) 3600 KB/s (150 KB/s at 1X CD rate) 10,800 KB/s (1352 KB/s at 1X DVD rate) 16.6 MB/s	
Startup time < 15 seconds		
	op time < 6 seconds	

Table 6-10			
8X DVD	O-ROM Drive		
Applicable disk	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge		
Center hole diameter	1.5 cm 0.59 in		
Disk diameter	12 cm, 8 cm		
Disk thickness	1.2 mm 0.047 in		
Track pitch	0.74 μm		
Access time			
Random DVD media Full stroke DVD media Random CD media Full stroke CD media	< 150 ms < 225 ms < 110 ms < 200 ms		
Audio output level	Line-out, 0.7 Vrms		
Cache buffer	512 KB/s		
Data transfer rate			
Max 24X CD Max 8X DVD	3600 KB/s (150 KB/s at 1X CD rate) 10,800 KB/s (1352 KB/s at 1X DVD rate)		
Multiword DMA mode 2 16.6 MB/s			
Startup time < 10 seconds			
Stop time < 3 seconds			

Table 6-11 24X CD-ROM Drive			
Applicable disk	DVD-5, DVD-9, DVD-10 CD-ROM (Mode 1 and 2) CD Digital Audio CD-XA ready (Mode 2, Form 1 and 2) CD-I ready (Mode 2, Form 1 and 2) CD-R (read only) CD Plus Photo CD (single/multisession) CD-Bridge		
Center hole diameter	1.5 cm	0.59 in	
Disk diameter	12 cm, 8 cm		
Disk thickness	1.2 mm	0.047 in	
Track pitch	1.6 µm		
Access time			
Random Full stroke	< 150 ms < 300 ms		
Audio output level	Line-out, 0.7 Vrms		
Cache buffer	128 KB/s		
Data transfer rate			
Sustained (16X) Variable Multiword DMA mode 2	2400 KB/s 1500 to 3600 KB/s 16.6 MB/s	(10X to 24X)	
Startup time	< 8 seconds		
Stop time < 4 seconds			

System DMA		
Hardware DMA	System Function	
DMA0	Available for audio	
DMA1*	Entertainment audio (default; alternate = DMA0, DMA3, none)	
DMA2*	Diskette drive	
DMA3	ECP parallel port LPT1 (default; alternate = DMA0, none)	
DMA4	DMA controller cascading (not available)	
DMA5*	Available for PC Card	
DMA6	Not assigned	
DMA7	Not assigned	
*PC Card controller can use DMA 1, 2, or 5.		

Hardware IRQ	System Function
IRQ0	System timer
IRQ1	Keyboard controller
IRQ2	Cascaded
IRQ3	COM2
IRQ4	COM1
IRQ5	Audio (default)*
IRQ6	Diskette drive
IRQ7	Parallel port
IRQ8	Real time clock (RTC)
IRQ9	Infrared
IRQ10	System use
IRQ11	System use
IRQ12	Internal point stick or external mouse
IRQ13	Coprocessor (not available to any peripheral)
IRQ14	IDE interface (hard drive and optical drive)
IRQ15	System use
Ø	PC Cards may assert IRQ3, IRQ4, IRQ5, IRQ7, IRQ9, IRQ10, IRQ11, or IRQ15. Either the infrared or the serial port may assert IRQ3 or IRQ4.
*Default conf	figuration; audio possible configurations are IRQ5, IRQ7, IRQ9,

Table 6-13 System Interrupts

*Default configuration; audio possible configurations are IRQ5, IRQ7, IRQ9, IRQ10, or none.

Table 6-14 System I/O Addresses

I/O Address (hex)	System Function (shipping configuration)
000 - 00F	DMA controller no. 1
010 - 01F	Unused
020 - 021	Interrupt controller no. 1
022 - 024	Opti chipset configuration registers
025 - 03F	Unused
02E - 02F	87334 "Super I/O" configuration for CPU
040 - 05F	Counter/timer registers
044 - 05F	Unused
060	Keyboard controller
061	Port B
062 - 063	Unused
064	Keyboard controller
065 - 06F	Unused
070 - 071	NMI enable/real time clock (RTC)
072 - 07F	Unused
080 - 08F	DMA page registers
090 - 091	Unused
092	Port A
093 - 09F	Unused
0A0 - 0A1	Interrupt controller no. 2

Table 6-14	
System I/O Addresses (Continued)	

I/O Address (hex)	System Function (shipping configuration)
0A2 - 0BF	Unused
0C0 - 0DF	DMA controller no. 2
0E0 - 0EF	Unused
0F0 - 0F1	Coprocessor busy clear/reset
0F2 - 0FF	Unused
100 - 16F	Unused
170 - 177	Secondary fixed disk controller
178 - 1EF	Unused
1F0 - 1F7	Primary fixed disk controller
1F8 - 200	Unused
201	Joystick (decoded in ESS1688)
202 - 21F	Unused
220 - 22F	Entertainment audio
230 - 26D	Unused
26E - 26	Unused
278 - 27F	Unused
280 - 2AB	Unused
2A0 - 2A7	Unused
2A8 - 2E7	Unused
2E8 - 2EF	Reserved serial port

Table 6-14	
System I/O Addresses (Continued)

I/O Address (hex)	System Function (shipping configuration)
2F0 - 2F7	Unused
2F8 - 2FF	Infrared port
300 - 31F	Unused
320 - 36F	Unused
370 - 377	Secondary diskette drive controller
378 - 37F	Parallel port (LPT1/default)
380 - 387	Unused
388 - 38B	FM synthesizer—OPL3
38C - 3AF	Unused
3B0 - 3BB	VGA
3BC - 3BF	Reserved (parallel port/no EPP support)
3C0 - 3DF	VGA
3E0 - 3E1	PC Card controller in CPU
3E2 - 3E3	Unused
3E8 - 3EF	Internal modem
3F0 - 3F7	"A" diskette controller
3F8 - 3FF	Serial port (COM1/default)
CF8 - CFB	PCI configuration index register (PCIDIVO-1)
CFC - CFF	PCI configuration data register (PCIDIVO-1)

Size	Memory Address	System Function
OIZC	Memory Address	System r unetion
640 KB	0000000-0009FFFF	Base memory
128 KB	000A0000-000BFFFF	Video memory
48 KB	000C0000-000CBFFF	Video BIOS
160 KB	000C8000-000E7FFF	Unused
64 KB	000E8000-000FFFFF	System BIOS
15 MB	00100000-00FFFFFF	Extended memory
58 MB	01000000-047FFFFF	Super extended memory
58 MB	04800000-07FFFFFF	Unused
2 MB	0800000-080FFFF	Video memory (direct access)
4 GB	08200000-FFFEFFFF	Unused
64 KB	FFFF0000-FFFFFFFF	System BIOS

Table 6-15 System Memory Map

A

Connector Pin Assignments

Table A-1 RJ-45 Network Interface

Pin	Signal	Pin	Signal
1	Transmit +	5	Unused
2	Transmit –	6	Receive –
3	Receive +	7	Unused
4	Unused	8	Unused

Table A-2 RJ-11 Modem

 $1^{2}3^{4}5^{6}$

Pin	Signal	Pin	Signal
1	Unused	4	Unused
2	Tip	5	Unused
3	Ring	6	Unused

Table A-3 Universal Serial Bus



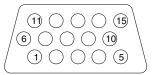
Pin	Signal	Pin	Signal
1	+5 VDC	3	Data +
2	Data –	4	Ground

Table A-4 S-Video



Pin	Signal	Pin	Signal
1	Ground (Y)	3	Y-Luminance (Intensity)
2	Ground (C)	4	C-Chrominance (Color)

Table A-5 External Monitor



Pin	Signal	Pin	Signal
1	Red analog	9	+5 VDC
2	Green analog	10	Ground
3	Blue analog	11	Monitor detect
4	Not connected	12	DDC 2B data
5	Ground	13	Horizontal sync
6	Ground analog	14	Vertical sync
7	Ground analog	15	DDC 2B clock
8	Ground analog		

Table A-6
Audio Line-Out

Pin	Signal	Pin	Signal
1	Audio out	2	Ground

Table A-7 Microphone

Pin	Signal	Pin	Signal
1	Audio in	2	Ground

Table A-8 Parallel

1	(@ 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	
l	0000000000000000	

Pin	Signal	Pin	Signal
1	Strobe	14	Auto Linefeed
2	Data Bit 0	15	Error
3	Data Bit 1	16	Initialize Printer
4	Data Bit 2	17	Select In
5	Data Bit 3	18	Ground
6	Data Bit 4	19	Ground
7	Data Bit 5	20	Ground
8	Data Bit 6	21	Ground
9	Data Bit 7	22	Ground
10	Acknowledge	23	Ground
11	Busy	24	Ground
12	Paper End	25	Ground
13	Select		

Power Cord Set Requirements

3-Conductor Power Cord Set

The wide range input feature of the notebook permits it to operate from any line voltage from 100 to 120 or 220 to 240 volts AC.

The power cord set received with the notebook meets the requirements for use in the country where the equipment is purchased.

Power cord sets for use in other countries must meet the requirements of the country where the notebook is used. For more information on power cord set requirements, contact an HP authorized reseller or service provider.

General Requirements

The following requirements are applicable to all countries:

- The length of the power cord set must be at least 1.5 meters (5 feet) and a maximum of 2 meters (6.50 feet).
- All power cord sets must be approved by an acceptable accredited agency responsible for evaluation in the country where the power cord set will be used.
- The power cord set must have a minimum current capacity of 10 amps and a nominal voltage rating of 125 or 250 volts AC, as required by each country's power system.
- The appliance coupler must meet the mechanical configuration of an EN 60 320/IEC 320 Standard Sheet C13 connector for mating with the appliance inlet on the back of the notebook.

Country-Specific Requirements

3-Conductor Power Cord Set Requirements			
Country	Accredited Agency	Applicable Note Number	
Australia	EANSW	1	
Austria	OVE	1	
Belgium	CEBC	1	
Canada	CSA	2	
Denmark	DEMKO	1	
Finland	FIMKO	1	
France	UTE	1	
Germany	VDE	1	
Italy	IMQ	1	
Japan	METI	3	
The Netherlands	KEMA	1	
Norway	NEMKO	1	
Sweden	SEMKO	1	
Switzerland	SEV	1	

Country	Accredited Agency	Applicable Note Number
United Kingdom	BSI	1
United States	UL	2

3-Conductor Power Cord Set Requirements (Continued)

Notes

- 1. The flexible cord must be <HAR> Type HO5VV-F, 3-conductor, 1.0 mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country where it will be used.
- The flexible cord must be Type SPT-3 or equivalent, No. 18 AWG, 3-conductor. The wall plug must be a two-pole grounding type with a NEMA 5-15P (15 A, 125 V) or NEMA 6-15P (15 A, 250 V) configuration.
- 3. The appliance coupler, flexible cord, and wall plug must bear a "T" mark and registration number in accordance with the Japanese Dentori Law. The flexible cord must be Type VCT or VCTF, 3-conductor, 1.00 mm² conductor size. The wall plug must be a two-pole grounding type with a Japanese Industrial Standard C8303 (7 A, 125 V) configuration.

С

Screw Listing

This appendix provides specification and reference information for the screws used in the notebook. All screws listed in this appendix are available in the Miscellaneous Screw Kit, spare part number 337012-001.

	Table C-1	
Phillips	PM2.5×7.0	Screw

	Color	Qty.	Length	Thread	Head Width		
	Black	14	7.0 mm	2.5 mm	5.0 mm		
Where used:							
Two screws that secure (documented in Section)		lrive to t	he notebook	(
One screw that secures (documented in Section)		al drive to	o the notebo	ook			
Two screws that secure	the displa	y assem	bly to the no	otebook			
(documented in Section 5.15)							

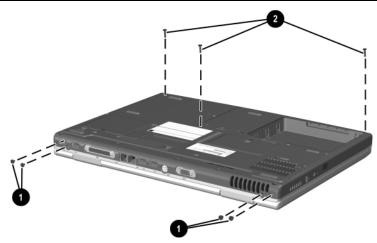
Phillips PM2.5×7.0 Screw Locations

Table C-1
Phillips PM2.5×7.0 Screw (Continued)

mm	Color	Qty.	Length	Thread	Head Width
	Black	14	7.0 mm	2.5 mm	5.0 mm

• Four screws that secure the display assembly to the notebook through the rear panel (documented in Section 5.15)

Three screws that secure the top cover to the notebook (documented in Section 5.16)

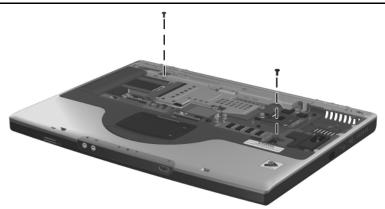


Phillips PM2.5×7.0 Screw Locations

mm	Color	Qty.	Length	Thread	Head Width
	Black	14	7.0 mm	2.5 mm	5.0 mm

Where used:

Two screws that secure the top cover to the notebook (documented in Section 5.16)



Phillips PM2.5×7.0 Screw Locations

Table C-2Phillips PM2.5×3.5 Screw

■ =+ mm	Color	Qty.	Length	Thread	Head Width
	Silver	4	3.5 mm	2.5 mm	5.0 mm

Four screws that secure the hard drive to the hard drive cover and shield (documented in Section 5.3)



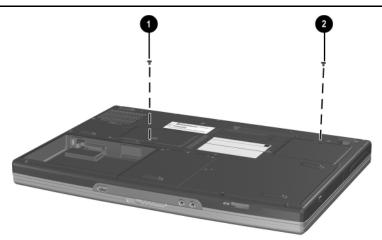
Phillips PM2.5×3.5 Screw Locations

	Table C-3	
Phillips	PM2.5×5.0	Screw

m m	Color	Qty.	Length	Thread	Head Width
	Black	13	5.0 mm	2.5 mm	5.0 mm

• One screw that secures the memory expansion compartment cover to the notebook (documented in Section 5.5)

One screw that secures the mini PCI compartment cover to the notebook (documented in Section 5.6)



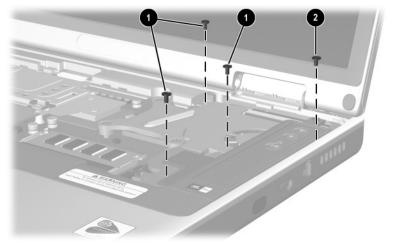
Phillips PM2.5×5.0 Screw Locations

mm	Color	Qty.	Length	Thread	Head Width
	Black	13	5.0 mm	2.5 mm	5.0 mm

Where used:

• Three screws that secure the speaker cover to the notebook (documented in Section 5.11)

One screw that secures the fan to the notebook (documented in Section 5.12)

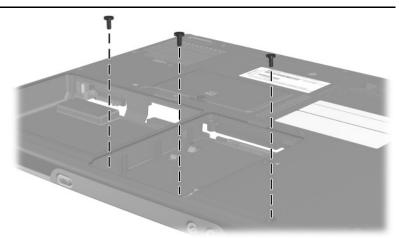


Phillips PM2.5×5.0 Screw Locations

Color	Qty.	Length	Thread	Head Width
Black	13	5.0 mm	2.5 mm	5.0 mm

Where used:

Three screws that secure the top cover to the notebook (documented in Section 5.16)

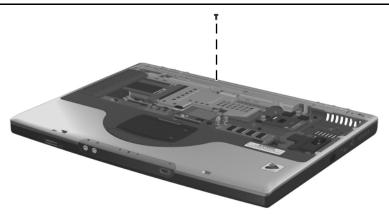


Phillips PM2.5×5.0 Screw Locations

Color	Qty.	Length	Thread	Head Width
Black	13	5.0 mm	2.5 mm	5.0 mm

Where used:

One screw that secures the top cover to the notebook (documented in Section 5.16)

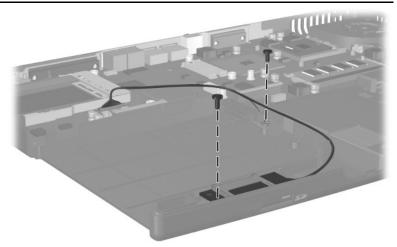


Phillips PM2.5×5.0 Screw Location

Color	Qty.	Length	Thread	Head Width
Black	13	5.0 mm	2.5 mm	5.0 mm

Where used:

Two screws that secure the SD Card slot board and cable to the notebook (documented in Section 5.17)

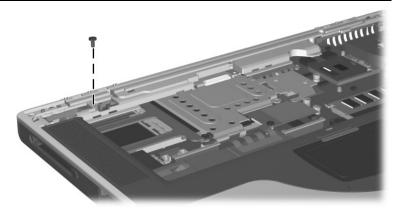


Phillips PM2.5×5.0 Screw Locations

m m	Color	Qty.	Length	Thread	Head Width
	Black	13	5.0 mm	2.5 mm	5.0 mm

Where used:

One screw that secures the system board to the notebook (documented in Section 5.20)



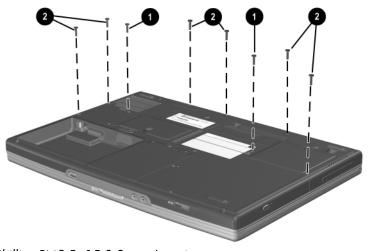
Phillips PM2.5×5.0 Screw Location

	Table C-4	
Phillips	PM2.5×15.0	Screw

 mm://////////////////////////////	Color	Qty.	Length	Thread	Head Width
	Black	10	15.0 mm	2.5 mm	5.0 mm
Whore used:					

• Two screws that secure the keyboard to the notebook (documented in Section 5.9)

Six screws that secure the top cover to the notebook (documented in Section 5.16)

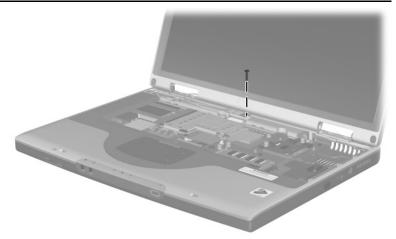


Phillips PM2.5×15.0 Screw Locations

mm	Color	Qty.	Length	Thread	Head Width
	Black	10	15.0 mm	2.5 mm	5.0 mm

Where used:

One screw that secures the display assembly cable to the notebook (documented in Section 5.15) $\,$

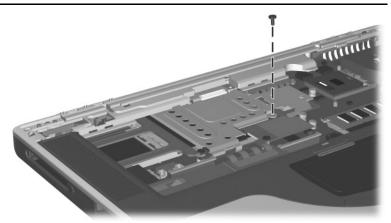


Phillips PM2.5×15.0 Screw Location

Color	Qty.	Length	Thread	Head Width
Black	10	15.0 mm	2.5 mm	5.0 mm

Where used:

One screw that secures the VGA shield to the notebook (documented in Section 5.15)

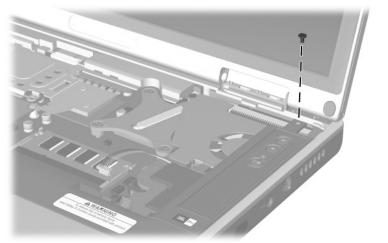


Phillips PM2.5×15.0 Screw Location

Table C-5Phillips PM2.5×3.0 Screw

■ mm॥।।।।।।।।।।।।।	Color	Qty.	Length	Thread	Head Width
	Black	1	3.0 mm	2.5 mm	5.0 mm

One screw that secures the speaker cover to the notebook (documented in Section 5.11) $\,$



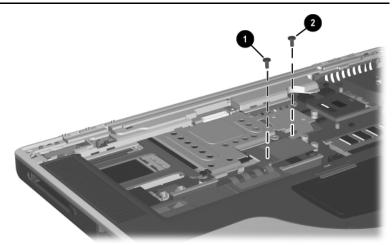
Phillips PM2.5×3.0 Screw Location

	Table C-6	
Phillips	PM2.0×3.0	Screw

≣⊕ ⊫ mm!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!!	Color	Qty.	Length	Thread	Head Width
	Black	2	3.0 mm	2.0 mm	4.0 mm

• One screw that secures the top cover to the notebook (documented in Section 5.16)

One screw that secures the VGA shield to the notebook (documented in Section 5.18)



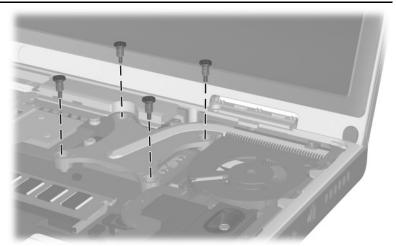
Phillips PM2.0×3.0 Screw Locations

Table C-7 Phillips PM2.0×9.0 Spring-Loaded Screw

Color	Qty.	Length	Thread	Head Width
Silver	4	9.0 mm	2.0 mm	6.0 mm

Where used:

Four screws that secure the heat sink to the notebook (documented in Section 5.13)



Phillips PM2.0×9.0 Spring-Loaded Screw Locations

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